HP 13255

CARTRIDGE TAPE MODULE

Manual Part No. 13255-91032

PRINTED

AUG-01-76

DATA TERMINAL TECHNICAL INFORMATION





1.0 INTRODUCTION.

The Cartridge Tape Module consists of a Cartridge Tape Unit (CTU) Interface PCA, a Read/write PCA, a CTU Top Plane Assembly, two CTU Transport Assemblies, and one or more mini tape cartridges. Each tape cartridge contains 150 feet of single-track 0.150-inch tape with a maximum formatted storage capacity of 110K eight-bit data bytes. The dual cartridge tape units provide full read and write capabilities for phase-encoded data. Data, command, status information, and address interfacing between this subsection and other terminal modules is provided by the Backplane Assembly and CTU Interface PCA. The Read/Write PCA controls recording, reading, and tape motion of the two CTU Transport Assemblies. Interfacing between the two PCA's is provided by the CTU Top Plane Assembly and interfacing between the Read/Write PCA and the two CTU Transport Assemblies is provided by a Motor Cable Assembly and two CTU ribbon cable assemblies.

2.0 OPERATING PARAMETERS.

A summary of operating parameters for the Cartridge Tape Module is contained in tables 1.0 through 5.3.

١ Size (L x W x D) Weight I Part Number +/-0.100 Inches (Pounds) Nomenclature 1 | 02640-60021 | CTU Top Plane Assembly $4.4 \times 1.1 \times 0.7$ 1 02640-60032 | Read/Write PCA $12.5 \times 4.0 \times 0.6$ 0.60 | 02640-60033 | CTU Interface PCA $12.5 \times 4.0 \times 0.5$ 0.40 02640-60034 | Cartridge Electronics PCA 3.8 x 2.0 x 1.3 0.10 02640-60050 | CTU Transport Assembly 5.1 x 3.6 x 3.8 0.80 1 02640-60054 | CTU Base Assembly N/A N/A | 02640-60055 | Motor/Tachometer Assembly N/A N/A | 02640-60056 | Head Bridge Assembly N/A N/A 1 02640-60057 | Tachometer Coil Assembly N/A N/A | 02640-60066 | CTU Cable Assembly N/A N/A | 02640-60067 | Head Assembly N/A N/A | 02640-60074 | Magnet Assembly N/A N/A 02640-60076 | Disc/Capstan Assembly N/A N/A 02640-60085 | Motor Cable Assembly N/A N/A 02640-60102 | CTU Bezel Assembly N/A N/A 9162-0061 | Mini Cartridge N/A N/A ۱ Number of Backplane Slots Required: 2

Table 1.0 Physical Parameters

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NOTE: This document is part of the 264XX DATA TERMINAL product series Technical Information Package (HP 13255).

1.0 INTRODUCTION.

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Size (L x W x D) | Part Weight I +/-0.100 Inches Nomenclature (Pounds) Number | 02640-60021 | CTU Top Plane Assembly 1 $4.4 \times 1.1 \times 0.7$ 1 0.10 | 02640-60032 | Read/Write PCA $12.5 \times 4.0 \times 0.6$ ı 0.60 0.40 | 02640-60033 | CTU Interface PCA 12.5 x 4.0 x 0.5 | 02640-60034 | Cartridge Electronics PCA 3.8 x 2.0 x 1.3 0.10 1 02640-60050 | CTU Transport Assembly 5.1 x 3.6 x 3.8 0.80 1 02640-60054 | CTU Base Assembly N/A N/A 1 02640-60055 | Motor/Tachometer Assembly N/A N/A | 02640-60056 | Head Bridge Assembly N/A N/A 02640-60057 | Tachometer Coil Assembly N/A N/A 02640-60066 | CTU Cable Assembly 02640-60067 | Head Assembly N/A N/A N/A N/A 1 02640-60074 | Magnet Assembly N/A N/A N/A 02640-60076 | Disc/Capstan Assembly N/A 02640-60085 | Motor Cable Assembly N/A N/A 02640-60102 | CTU Bezel Assembly N/A N/A 9162-0061 | Mini Cartridge N/A N/A Number of Backplane Slots Required: 2

Table 1.0 Physical Parameters

Table 2.0 Reliability and Environmental Information

```
Environmental: ( X ) HP Class B ( ) Other:
  Restrictions:
              Type tested at product level except the cartridge
              tape. The cartridge tape limits temperature and
              humidity conditions as follows.
              Free space ambient temperature:
                  Non-operating: -10 to + 65 degrees C
                              (-15 to +150 degrees F)
                     Operating: + 5 to + 40 degrees C
                              (+41 \text{ to } +104 \text{ degrees } F)
              Humidity: 20 to 80% (non-condensing)
Failure Rate (percent per 1000 hours) of Major Assemblies:
        CTU Interface PCA
                              0.82340%
        Read/Write PCA
                              4.04199%
                              0.00088%
        CTU Top Plane Assembly
        Motor Cable Assembly
                              0.00060%
        CTU Transport Assembly
                              4.17800%
  Life expectancy for components of the CTU Transport Assembly (the maximum
  insertion rate = 1 per second. Data for the head, motor, and motor
  capStan apply to start-stop motion at 10 inches per second):
                           20,000 insertions min. (50,000 typical)
    Eject, Insert Mechanism
    Cartridge Insert and
                           100,000 insertions min.
     File Protect Switches
    Read/Write Head
                             3,000 hours min. (10,000 hours typical)
   Motor
                             1,000 hours min. (5,000 hours typical)
   Motor Capstan
                             1,000 hours min. (5,000 hours typical)
```

Table 3.0 Total Module Power Supply and Clock Requirements - Measured while Accelerating to 60 ips (At +/-5% Unless Otherwise Specified)

######################################			
+5 Volt Supply	+12 Volt Supply	-12 Volt Supply	+42 Volt Supply
⊌ 1350 mA	e 1630 mA	@ 1580 mA	Am 9
		; 	NOT APPLICABLE
115 vo	its ac	 220 vol	ts ac
(A	i 	Α !
NOT APPI	LICABLE	NOT APPL	ICABLE
!			ļ
1	Clock Frequency:	4.915 MHZ	
1			i

Table 4.0 Connector Information for CTU Interface PCA

Tal	ole 4.0 Connector	r Information for CTU Interface PCA
Connector	Signal	Signal
I and Pin No.	=	Description
2222222222		
P1, Pin 1	+5 V	+5 Volt Power Supply
-2	GND (Ground Common Return (Power and Signal)
-3	SYS CLK	4.915 MHz System Clock
-4	-12V	-12 Volt Power Supply
-5	ADDRO	Negative True, Address Bit 0
-6	ADDR1	Negative True, Address Bit 1
- 7	ADDR2	Negative True, Address Bit 2
-8	ADDR3	Negative True, Address Bit 3
-9	ADDR4	Negative True, Address Bit 4
-10	ADDR5	Negative True, Address Bit 5
-11	ADDR6	Negative True, Address Bit 6
-12	ADDR7	Negative True, Address Bit 7
-13	ADDR8	Negative True, Address Bit 8
-14	ADDR9	Negative True, Address Bit 9
-15	ADDR10	Negative True, Address Bit 10
-16	ADDR11	Negative True, Address Bit 11
-17	ADDR12	Negative True, Address Bit 12
-18	ADDR13	Negative True, Address Bit 13
-19	ADDR14	Negative True, Address Bit 14
-20	ADDR15	Negative True, Address Bit 15
-21	1/0	Negative True, Input Output/Memory
-22	GND	Ground Common Return (Power and Signal)

Table 4.0 Connector Information for CTU Interface PCA (Cont'd.)

Connector	l Signal	Signal
I and Pin No.	Name	Description I
==========	======================================	
P1, Pin A	I GND	Ground Common Return (Power and Signal)
-B	POLL	Negative True, Polled Interrupt Identification Request
-c	+12V	+12 Volt Power Supply
-D	PWR ON	System Power On
-Е	BUS0	Negative True, Data Bus Bit 0
-F	BUS1	Negative True, Data Bus Bit 1
-н	BUS2	Negative True, Data Bus Bit 2
- J	BUS3	Negative True, Data Bus Bit 3
-к	BUS4	Negative True, Data Bus Bit 4
-L	BUS5	Negative True, Data Bus Bit 5
_M	BUS6	Negative True, Data Bus Bit 6
- N	BUS7	Negative True, Data Bus Bit 7
-p	WRITE	Negative True, Write/Read Type Cycle
-R	ATN2	Negative True, CTU and Polled Interrupt Request
-s	WAIT	Negative True, Wait Control Line
-т	PRIOR IN	Bus Controller Priority In
- U	PRIOR OUT	Bus Controller Priority Out
-v	PROC ACTIVE	Negative True, Processor Active (Controlling Bus)
- W	BUSY	Negative True, Bus Currently Busy (Not Available)
-x	RUN	Allow Processor to Access Bus
-Y	REQ	Negative True, Request (Bus Data Currently Valid)
 -Z ============	ATN	Negative True, Data Comm Interrupt Request

Table 4.1 Connector Information for CTU Interface PCA

	ole 4.1 Connector	I INIOIMACION FOR CIO INCEPTACE PCA
Connector	· •	Signal
and Pin No.		Description
1 P3, Pin 1		} Not } Used
tnru -22	 	
P3, Pin A	10	Negative True, Lamp Unit 0
-в	HOLO	Negative True, Hole Unit O Detected
-c	L1	Negative True, Lamp Unit 1
-D	HOL1	Negative True, Hole Unit 1 Detected
-Е	+5 V	+5V Supply
-F	RE	Negative True, Record Enable (Read Enable)
-н	uso	Unit Select 0 (select left unit)
-J	DATA	Negative True, Write Data (high Writes flux in north seeking pole direction)
-к	I 2XTACH	Two Times Tachometer Frequency
-L	I RUNG	Running (>1 ips forward or reverse)
- м	TACH	Tachometer Frequency
- N	DZX	Data Zero Crossing (testing purposes only)
-P	GAP	
- R	CINO	Cartridge Inserted in Unit 0
- s	CIN1	Cartridge Inserted in Unit 1
-т	 RIP	Record In Progress
- U	DZX	Negative True, Data Zero Crossing
-v	STOP	Obsolete (tied to +5V thru 4.7 kilohms)
-w	FFD	Negative True, Fast Forward
-x	SFD	Negative True, Slow Forward
-Y	FREV	Negative True, Fast Reverse
-z	I ——— I SREV	Negative True, Slow Reverse

Table 4.2 Connector Information for Read/Write PCA

=======================================		
<pre>Connector</pre>	i Signal	Signal
and Pin No.	l Name	Description
J4 & J5 1	TCOM	Tachometer Coil (Common), D.C. Level +2.5V
-2		Not Used
-3	HEAD-	Head (-) AC Signal, Data Dependent
-4	HEAD GND	Head Ground
-5	CI	Negative True, Cartridge Inserted
-6 1	HOLE	Negative True, Hole
-7) +5V 	+5V Supply
-8	+5V RET	+5V Return
-9	L L	Negative True, Lamp
-10	HEADCT	Head Center Tap, AC Signal, Data Dependent, Active on Write Only
-11	HEAD+	Head (+) AC Signal, Data Dependent
-12	TGND	Tachometer Ground
-13		Not Used
-14	T	Tachometer Coil, AC Signal, Frequency Depends on Motor Speed
 J6 -1	•	Motor 0 (-)
-2	+	Motor 0 (+)
-3	-	Motor 1 (-)
-4	+	Motor 1 (+)
1		

Table 4.3 Connector Information for Read/Write PCA

		or intolugation for regarative by
Connector	Signal	Signal
I and Pin No. 1		Description
=======================================		
P1, Pin 1	+5 V	+5 Volt Power Supply
-2	GND	
-2	GND	Gloding Common Reculif (Fower and bighal)
i -3 i		Not Used I
!		
-4	-12V	-12 Volt Power Supply
Pin -5		1 4 }
through		l} Not Used
l Pin -22 l		1)
P1, Pin A		}
through		Not Used
Pin -B		
-c	+12V	+12 Volt Power Supply
i		
1. Pin -D		1}
through I		} Not Used
Pin -S		}
-т	PRIOR IN	 Bus Controller Priority In
, - <u>1</u> ,	evior in	
i -u i	PRIOR OUT	Bus Controller Priority Out
!		!
Pin -V		
through		} Not Used
Pin -Z I		<i> </i>

Table 4.4 Connector Information for Read/Write PCA

Connector	Signal Name	Signal Description
P3, Pin 1 through Pin -6		} } Not Used }
-7	GND	Ground
Pin -8 through Pin -22	 	

Table 4.4 Connector Information for Read/write PCA (Cont'd.)

Table	4.4 Connector in	tormation for Read/write PCA (Cont'd.)
Connector	Name	Signal Description
P3, Pin A	ro -	Negative True, Lamp Unit 0
-в	HOLO	Negative True, Hole Unit O Detected
-c	<u>1</u>	Negative True, Lamp Unit 1
-D	HOL1	Negative True, Hole Unit 1 Detected
-E	 +5V	+5V Supply
-ғ	RE	Negative True, Record Enable (Read Enable)
-н	USO	Unit Select 0 (select left unit)
-J	DATA	Negative True, Write Data (nigh writes flux in north seeking pole direction)
-к	2XTACH	Two Times Tachometer Frequency
-L	RUNG	Running (>1 ips forward or reverse)
-м	ТАСН	Tachometer Frequency
-N	DZX	Data Zero Crossing (testing purposes only)
-P	GAP I	Gap Detector
-R	CINO	Cartridge Inserted in Unit 0
-s	CIN1	Cartridge Inserted in Unit 1
-т	RIP	Pecord In Progress
-U	DZX	Negative True, Data Zero Crossing
-v	STOP	Obsolete (tied to +5V thru 4.7 kilohms)
- W	FFD	Negative True, Fast Forward
-x	SFD	Negative True, Slow Forward
- Y	FREV	Negative True, Fast Reverse
-Z	SREV	Negative True, Slow Reverse

Table 4.5 Connector Information for Cartridge Electronics PCA

_	Table	4.5 Connector In	formation for Cartridge Electronics PCA
1	Connector and Pin No.	Name	Signal Description
1	J1 1	T	Tachometer Coil, AC Signal, Frequency Depends on Motor Speed
(-2	TGND	Tachometer Ground
(- 3	TCOM	Tachometer Coil (Common), DC Level +2.5V
- (
į	J2 - 1	TCOM	Tachometer Coil (Common), DC Level +2.5V
Ì	-2	į	Not Used
	-3	HEAD-	Head (-) AC Signal, Data Dependent
(-4	HEAD GND	Head Ground
	- 5	CI	Negative True, Cartridge Inserted
	- 6	HOLE	Negative True, Hole
(- 7	+5V	+5V Supply
1	-8	+5V RET	+5V Return
- 1	•9	L	Negative True, Lamp
(-10	HEADCT	Head Center Tap, AC Signal, Data Dependent, Active on Write Only
1	-11	HEAD+	Head (+) AC Signal, Data Dependent
	-12	TGND	Tachometer Ground
(-13		Not Used
1	-14	T	Tachometer Coil, AC Signal, Frequency Depends on Motor Speed

Table 5.0 Module Bus Pin Assignments

Funct	======================================	1	:======== Bus
	ormed: Read Data From CTU	Value	
	ormeat near back from 610		=====================================
		ixi	ADDR 15
Poll	Bit: Bit 7	l X	ADDR 14
		1 X I	ADDR 13
Modu]	Le Address: $(ADDR 11,10,9,4) = (1011)$	1 X 1	ADDR 12
		1 1 1	ADDR 11
		1 0 1	ADDR 10
		1	ADDR 9
Funct	tion Specifier: ADDR5 = 1	1 X I	ADDR 8
		I X I	ADDR 7
	• • • • • • • • • • • • • • • • • • • •	1 X 1	ADDR 6
Data	Bus Bit Interpretation:	1	ADDR 5
		1	ADDR 4
		I X I	,,,,,,
B7	Data Bit 7	l X l	ADDR 2
()	Most significant bit of data)	l X I	ADDR 1
		X ======	ADDR 0
B6	Data Bit 6	1 B7 1	BUS 7
n o	Data off o	1 B6 I	
		I B5	BUS 5
85	Data Bit 5	1 B4	BUS 4
03	baca tite 3	I B3	
		i B2	
B4	Data Bit 4	i 81	BUS 1
-		1 BO	
вЗ	Data Bit 3	1=Logica	1 1=Bus Low
			1 0=Bus High
		IX=Don't	
B2	Data Bit 2		
B1	Data Bit 1		
BÚ	Data Bit 0		
(I	geast significant bit of data)		

Table 5.1 Module Bus Pin Assignments

Funct:	-	!	Bus
Perio	rmed: Write Data To CTU	Value	
		======	
noll i	Bit: Bit 7	X X	ADDR 15 ADDR 14
FOIT !	pit: pit /	i X	ADDR 13
Madula	e Address: (ADDR 11,10,9,4) = (1011)	i X	ADDR 13
MOGUIE	e Address: (ADDR 11,10,9,4) - (1011)	1 1	ADDR 12 ADDR 11
		1 0	ADDR 10
		1 1	ADDR 10
Funct	ion Specifier: ADDR5 = 1	i X	ADDR 8
1 4116 6.	ton opecifies. Apply - 1	i X	ADDR 7
		i x	ADDR 6
nata i	Bus Bit Interpretation:		ADDR 5
Data i	bus bic interpretation.	iii	ADDR 4
		ix	ADDR 3
в7	Data Bit 7	ix	ADDR 2
	ost significant bit of data)	ix	ADDR 1
(11)	ose significant bit of adday	i â	ADDR 0
		=======	-
Вь	Data Bit 6	i 87	
			BUS 6
		1 85	
85	Data Bit 5	1 B4	
		1 83	
		i 82	
B4	Data Bit 4	1 в1	
		I B0 I	
		= = = = = = = = = = = = = = = = = = =	
B3	Data Bit 3	1=Logica	1 1=Bus Low
			1 0=Bus High
		X=Don't	
B2	Data Bit 2		:======================================
81	Data Bit 1		
B0	Data Bit 0		
(Le	east significant bit of data)		

Table 5.2 Module Bus Pin Assignments

Function	1	Bus
Performed: Input Status From CTU	Value	-
	•	========
Dally place and a		ADDR 1
Poll Bit: Bit 7	• ••	ADDR 1
	I X	ADDR 1
Module Address: $(ADDR 11, 10, 9, 4) = (1011)$	j X	ADDR 1
	1	ADDR 1
	1 0	ADDR 1
		ADDR
Function Specifier: ADDR5 = 0	i X	ADDR
	l X	ADDR
	j X	I ADDR
Data Bus Bit Interpretation:	0	ADDR
	1 1	I ADDR
B7 - Not Applicable	l X	ADDR
	, ,,	I ADDR
Bo - BYTE RDY is set to "1" in Read mode when the	l X	ADDR
preamble is detected or a byte is ready to be	l X	ADDR
read from the CTU Module or can be accepted for	•	=======
recording. BYTE RDY is set in Record mode when		BUS 7
a byte has been encoded.	1 B6	BUS 6
	,	BUS 5
Bb - GAP is the output of the gap detector on the		BUS 4
Read/Write PCA.	1 B3	I BUS 3
	1 B2	BUS 2
84 - HOLE is set to "1" whenever a hole is detected	I B1	BUS 1
on the tape and is cleared when status is read.	1 BO	BUS 0
B3 - TAK is the frequency of the tachometer divided		al 1=Bus L
by 2. There are 58.4 transitions of the TAK		al O=Bus H
status per inch of tape movement.	IX=Don't	Care
B2 - RIP indicates the presence of head current while		
The state of this signal is not defined during re	ad operat	tions or
while data is being recorded.		
<pre>0 = No write current (tape protected)</pre>		
<pre>1 = Write current present while in gap</pre>		
B1 - CIR indicates that a cartridge is inserted in the		
Transport Assembly and is cleared when the cartri		emoved.
0 = No cartridge in right CTU Transport Assemb		
<pre>1 = Cartridge inserted in right CTU Transport</pre>	Assembly	
BO - CIL indicates that a cartridge is inserted in the		
Transport Assembly and is cleared when the cartri		emoved.
0 = No cartridge in left CTU Transport Assembl		
<pre>1 = Cartridge inserted in left CTU Transport A</pre>	ssembly	

Table 5.3 Module Bus Pin Assignments

Function Performed Sutrut Command to CTU	1 7-1	Bus
Performed: Output Command to CTU	Value ======	Signal =======
	i x	ADDR 1
Poll Bit: Bit 7	1 X	ADDR 1
	1 X	ADDR 1
Module Address: $(ADDR 11, 10, 9, 4) = (1011)$	l X	ADDR 1
	1 1	ADDR 1
	1 0	ADDR 1
	t 1	I ADDR
Function Specifier: ADDR5 = 0	l X	I ADDR
	l X	ADDR
	l X	I ADDR
Data Bus Bit Interpretation:	1 0	ADDR
	1 1	ADDR
B7 - ANL	l X	ADDR
0 = Turns off left eject button light	l X	ADDR
<pre>1 = Turns on left eject button light</pre>	i X	I ADDR
D.C. AND	X	ADDR
Bb - ANR 0 = Turns off the right eject button light		BUS 7
1 = Turns on the right eject button light		BUS 6
1 - Turns on the right eject button right	I 85	BUS 5
B5 - GEN	1 84	BUS 4
0 = Disables gap recording	1 B3	BUS 3
1 = Record gap on tape (Bit 3 must also be 1)	i B2	BUS 2
a - hecota dab on cabe (bac a made daba ne 1)	i B1	BUS 1
B4 - USL		BUS 0
0 = Route command to right drive	=======	
1 = Route command to left drive	11=Logic	al 1=Bus L
		al O=Bus H
B3 - REC	X=Don't	Care
0 = Read mode	=======	========
<pre>1 = Record mode (enable write circuit)</pre>		
D) _ ECT		
B2 - FST 0 = Run tape at slow speed (10 ips)		
1 = Run tape at high speed (60 ips)		
r - wan cape at magn speed (ov rps)		
B1 - FWD		
0 = Forward		
1 = Reverse		
BO - RUN		
0 = Stop tape		
1 = Move tape according to FST and FWD		
- hote cabe decorated to tor and run		

FUNCTIONAL DESCRIPTION - CTU INTERFACE PCA. Refer to the block diagram (figure 1), schematic diagram (figure 2), component location diagram (figure 3), and parts lists (02640-60021 and 02640-60033) located in the appendix.

The terminal processor communicates with the Cartridge Tape Module via the terminal bus (Backplane Assembly). The CTU Interface PCA is responsible for converting processor commands into signals to control tape motion, unit selection, read or write operation, and the state of the eject button lights. The CTU Interface PCA provides status information allowing the processor to determine the present state of the selected CTU Transport Assembly. Finally, the CTU Interface PCA encodes data bytes into serial patterns of bit transitions to be recorded on the tape and vice versa (i.e., decodes bit transitions on the tape into data bytes).

- 3.0.1 BUS FUNCTION DECODER AND TIMING LOGIC CTU INTERFACE PCA.
- 3.0.1.1 The bus function decoder and timing logic generates signals based upon inputs from the terminal bus which control the flow of commands, status, and data bytes to and from the terminal bus.
- 3.0.1.2 The bus function decoder (U16) generates one of four command signals by decoding WRITE and ADDR5. The commands are enabled by I/O (for an I/O module), REQ (bus data is valid), ADDR4, ADDR11, ADDR10, and ADDR9. In addition, DATA CLOCK, RD+WRT, RD/WRT SELECT, READ EN, and STATUS EN are generated.
- 3.0.2 COMMAND LOGIC CTU INTERFACE PCA.
- 3.0.2.1 The purpose of the command logic is to acquire command information from the terminal bus when the signals are valid. The command information completely specifies the operation as well as the selection of the CTU Transport Assemblies. In addition, the command logic stops tape motion thus preventing tape runoff when a hole is detected by the hole detect logic.
- 3.0.2.2 The command signals from the terminal bus are latched into U15, U21 (Pins 5 and 6), and U24 by the CMND CLK signal from the bus function decoder and timing logic.

Two versions of the Run command are contained in the command register (U15). SRUN (Servo Run) is generated at U24, Pin 8 to enable the tape motion decoder (U16). SRUN is cleared if the hole edge detector (U23, Pin 12) detects a transition into a hole. IRUN (Interface Run) is generated at U24, Pin 6 to enable the slow forward tape motion decoder at

U36, Pin 8 which generates ISF (used only by the encoder/decoder logic). This prevents a discontinuity in encoded or decoded data when moving across a hole. Both SRUN and IRUN are cleared after a system reset.

The SRUN, FORWARD, and FAST signals are translated in this block into the signals SREV (slow reverse), SFD (slow forward), FREV (fast re-

verse), and FFD (fast forward) which are used by the servo electronics on the Read/Write PCA.

The CLRINT signal is generated for the interrupt logic by U27, Pin 8 when the processor performs a status request, enabling the STATUS EN signal. The CLRINT signal is present for one cycle of SYS CLK after STATUS EN goes low.

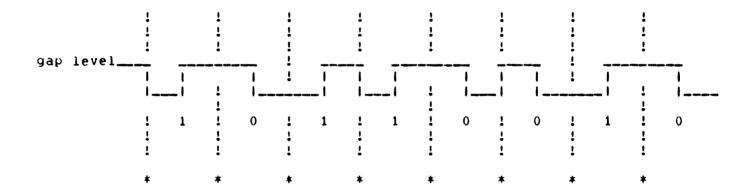
- 3.0.3 DATA PATH CONTROL CTU INTERFACE PCA.
- 3.0.3.1 The data path control circuitry transfers data to and from the terminal bus. It also converts serial bits from the tape into bytes and converts bytes from the terminal bus into serial bits.
- 3.0.3.2 The data I/O buffer (U13 and U33) is an 8-bit register with a 2-port input multiplexer. It provides one byte of buffering between the terminal bus and the serial data register.
- 3.0.3.3 In Record mode, the data is loaded into the data I/O buffer from the terminal bus, enabled by RD/WRT SELECT being low. (Note that the data buffer is loaded with complement data since it is loaded from the ground true terminal bus.) The data byte is loaded into the serial data register after the previous byte has been encoded. The serial

data register is then shifted right (via REC DATA) into the encoder at mid cell point (data transition position) and the encoder is complemented at end cell point (phase position).

3.0.3.4 In Read mode, the serial biphase data is read into the transition detector (U28, Pin 14) of the encoder/decoder logic and shifted into

the serial data register at the appropriate time (corresponding to the zone for data transitions). When the last data bit has been detected at the decoder (there are 7 bits in the serial data register), the data I/O buffer is parallel loaded from the serial data register (shifted right one bit). The data I/O buffer is subsequently output to the terminal bus via drivers U11 and U32, which are enabled by the READ EN signal.

- 3.0.4 ENCODER/DECODER LOGIC CTU INTERFACE PCA.
- 3.0.4.1 This logic provides the timing and control functions for encoding or decoding a data byte. The operation of the encoder/decoder logic is based upon the following theoretical analysis. The code that is recorded on the cartridge tape is Serial Biphase Mark Code (see below). Therefore, the code shown below would be seen at the encoder output (U17, Pin 10) when in Record mode or at the transition detector (U28, Pin 15) in Read mode. The code rules state that there is always a data transition at mid cell, a 1-bit is a transition towards gap level while a 0-bit is a transition away from gap level, and a phase transition occurs at a cell boundary if adjacent data transitions are the same.



*Indicates cell boundaries (125 microseconds)

3.0.4.2 Timing and control for the encode and decode operations is provided by a cell decode counter (U212) and a variable modulus (divide by N) counter (U213, U214, U312, and U313) which are both synchronous with the bus System Clock. The variable modulus counter generates a carry output at time intervals equal to one biphase cell period divided by eight which increments the cell decode counter. By initializing both counters at the beginning of a biphase cell, timing points (for encoding phase and data transitions in Read mode) and timing zones (for decoding phase and data transitions in Read mode) can be decoded from the cell decode counter and variable modulus counter carry output.

The variable modulus counter consists of two counters. One is an 8-bit counter (U213 and U214) which counts from a base state to the overflow state (which generates a carry output); the second is an 8-bit up-down counter which contains the value of the base state. The up-down counter is loaded with the two's complement of the desired modulus. In Record mode, the up-down counter is reset (U311, Pin 11 and U313, Pin 11) to the two's complement of 115 octal (77 decimal) giving a carry output at

In Read mode, the up-down counter is initialized to the same value. Then, based on the actual frequency of the phase/data transitions, the up-down counter is incremented or decremented. (Note that incrementing the up-down counter decrements the modulus of the counter.)

The cell decode counter is decoded as follows when in Record mode.

Α	В	U212, E C	D		FUNCTION
1	0				Phase Position
1	1	0	1	1	l Data Position

when in Read mode, the cell decode counter appears as follows.

			U21	12, Pi	ŧ		
		A	В	C	D	!	FUNCTION
Initialize	State	0	1	1	0	1}	Illegal Zone
		0	1	1	1	1}	For Transitions
Decrement		1	0	0	0	1}	
N		1	0	0	1	1)	Zone For Phase
Increment		1	0	1	0	1)	Transitions
N		1	0	1	1	1}	
Decrement		1	1	0	0	1)	
N		1	1	0	1	1)	Zone For Data
Increment		1	1	1	0	1)	Transitions
N		1	1	1	1	1)	

3.0.4.3 The encoder operation can be best explained by considering the recording of a gap and a 2-byte preamble. The preamble consists of a zero byte and a byte with the value 200 octal.

First, the command RUN.FORWARD.RECORD.GAP is output to the command register from the processor. This sets the encoder to record flux in the gap direction. Additionally, the command sets the modulus of the variable modulus counter to 77 and enables the preset signals of the variable modulus, bit, and cell decode counters. While the gap is being recorded, the serial data register is shifted right for each bit

time. Since DZX is set when in record mode, this results in the serial data register being loaded serially with all 1's. Because the data register contains the complement data, the register is effectively loaded with the first preamble byte (all zeroes).

After the proper gap interval has been recorded, the GAP command is turned off and the last preamble byte is loaded into the data I/O

buffer. When REC GAP is set, the preset signals on the variable modulus, bit, and cell decode counters are removed and the encoder is no longer forced to record in the gap direction.

Each bit is recorded (encoded) as follows:

- The variable modulus counter counts up and generates a carry output (CIN) every 77 system clocks. The carry output increments the cell decode counter.
- 2) The cell decode counter is decoded at mid cell setting the

 encoder to DATA (the value of the rightmost bit of the serial
 data register), and the serial data register is shifted right
 one bit.
- At end cell, the bit counter increments, the encoder is complemented, and the cell decode and variable modulus counters are initialized.

The process is repeated for each of the eight data bits. After all eight bits have been encoded, the bit counter, cell decode counter, and the variable modulus counter are initialized. The serial data register is loaded from the data I/O buffer and BYTE RDY is set. If BYTE RDY signal is already set, then data is not loaded from the data I/O buffer and the same byte is recorded, shifted right one bit.

3.0.4.4 The decoder operation can be similarly explained by decoding a record consisting of a gap, a 4-byte preamble and a 1-byte record. First, the command RUN.SLOW.FORWARD is output to the command register from the processor. While the gap is being read, the gap detect circuitry on the Read/Write PCA causes the modulus of the variable modulus counter to be preset to 77, initializes the variable modulus and cell decode counters, and clears READ SYNC (U17, Pin 6).

When the preamble begins to be read, the gap detect circuitry indicates data present. This causes the preset to be removed from the modulus of the variable modulus counter which allows the modulus to be adjusted accordingly. The decoder then proceeds as follows-

The variable modulus counter counts up and generats CIN every N system clocks (N is initially 77). CIN increments the cell decode

counter. When a transition is sensed by the DZX transition detector, it is decoded using the cell decode counter and results in one of three possible actions:

- Transition occurs in the illegal zone- the cell decode and variable modulus counters are initialized. The process continues waiting for the next transition.
- 2) Transition occurs in the phase zone- the modulus of the variable modulus counter is incremented or decremented (see 3.0.4.2) and the cell decode and variable modulus counters are initialized. The process continues waiting for the next transition.
- 3) Transition occurs in the data zone- the modulus of the variable modulus counter is incremented or decremented (see 3.0.4.2) and the cell decode and variable modulus counters are initialized. If the data is decoded as a zero ("0"), the process continues waiting for the next transition. Otherwise, a one ("1") indicates the end of the preamble and causes READ SYNC and BYTE RDY to be set.

When READ SYNC is set, the decoder will automatically switch modes to read in data bytes. The initial BYTE RDY indicates that the end of the

preamble has been found. BYTE RDY must be cleared by either a RD DATA

or WR DATA. However, the data byte read will be meaningless.

while reading in data, transitions detected are handled in the same manner as when reading the preamble except for transitions occuring in the data zone. In this case, RD DATA is shifted right into the serial data register and bit counter is incremented. When the last bit is decoded, the data I/O buffer is parallel loaded from the serial data register (shifted right one bit), BYTE RDY is set, and the process is repeated for the next byte. The data in the I/O buffer must be read (which clear BYTE RDY) before the next byte is decoded in order to avoid losing data.

- 3.0.5 HOLE DETECT LOGIC CTU INTERFACE PCA.
- 3.0.5.1 This circuitry detects the presence of a hole in the tape of either CTU Transport Assembly (depending on which transport is selected) and generates the DHOL, DHOL DET, and USO signals.
- 3.0.5.2 The Read/Write PCA provides the signals HOLO and HOL1 that indicate the presence of a hole on Unit 0 or Unit 1, respectively when the signal is low. When Unit 1 is selected and a hole is detected, U22, Pin 11 will be high. When Unit 0 is selected, USO at U35, Pin 4 is high, a hole is detected, and U22, Pin 8 is high. Pins 8 and 11 of U22 are wire ORed into U28, Pin 6 where they are synchronized to SYS CLK and provide the DHOL signal at U28, Pin 7. DHOL at U29, Pin 4 is exclusive-ORed with DHOL delayed by one cycle of SYS CLK at U29, Pin 5 and generates the DHOL DET signal which provides a pulse when a hole is initially detected and another pulse when it is no longer detected. It should be noted that DHOL and DHOL DET are ANDED in the command logic to provide a single pulse when a hole is initially detected.
- 3.0.6 TACH LUGIC CTU INTERFACE PCA.
- 3.0.6.1 The tach logic divides the TACH signal from the Read/Write PCA by a factor of two and uses the resulting signal to generate the signals TACH/2 and DTACH/2.
- 3.0.6.2 The TACH signal is used as the clock input for U26, which is configured as a T flip-flop, and results in one transition of the signal at U26, Pin 6 for every two transitions of the TACH signal. U28 synchronizes the signal from U26, Pin 6 with the SYS CLK and generates the TACH/2

signal for the status drivers. The TACH/2 signal is delayed one cycle of SYS CLK by U28, Pin 5 and is then exclusive-ORed to produce DTACH/2 at U29, Pin 8. DTACH/2 produces a pulse at each transition of TACH/2 with a width equal to one cycle of SYS CLK.

- 3.0.7 STATUS DRIVERS CTU INTERFACE PCA.
- 3.0.7.1 The status drivers present status information for the module to the terminal bus.
- 3.0.7.2 The CINO, CINI, RIP, and INTERRUPT signals are gated onto the terminal bus by U31 which is enabled by STATUS EN. The signals are inverted on the bus to provide ground true logic levels. The TACH, HOLE, GAP, and BYTE RDY signals are gated onto the terminal bus by U12 which is enabled by STATUS EN.
- 3.0.8 INTERRUPT LOGIC CTU INTERFACE PCA.
- 3.0.8.1 The interrupt logic provides an interrupt when a transition occurs in the TACH/2 signal, when a hole is present, or when a byte of data must be received or sent from the processor.
- 3.0.8.2 The DTACH/2 signal sets flip-flop U25, causing Pin 9 to be low when a transition occurs in TACH/2. The CLRINT signal from the command logic resets U25, causing Pin 9 to go high. The DHOL signal sets flip-flop U25, causing Pin 7 to be low, and indicates the presence of a hole in the tape. The CLRINT signal resets U25, causing Pin 7 to go high.

When U25, Pin 9 is low or U25, Pin 7 is low or BYTE RDY is low, or some combination of these events occurs, then INTERRUPT will be high. This

causes ATN2 to be low thereby indicating an interrupt condition to the

processor. If U25, Pin 7 is high and BYTE RDY is high, then no interrupt condition exists and INTERRUPT will be low.

FUNCTIONAL DESCRIPTION - READ/WRITE PCA. Refer to the block diagram (figure 4), schematic diagram (figure 5), component location diagram (figure 6), and parts list (02640-60032) located in the appendix.

The Read/Write PCA contains circuitry to record flux transitions onto cartridges in either CTU Transport, to convert flux transitions recorded on the cartridges into TTL signal levels, and to detect the

presence of gap (absence of flux transitions) on the tape. In addition, this PCA contains the servo electronics for controlling tape motion and speed for either CTU Transport. Analysis of the PCA indicates that much of the circuitry is common for servo control and read/write operations. The routing of signals is accomplished for each drive by the read select switch, the unit function decoder, the amplifier select logic, and the tachometer feedback select and conditioning circuits. (Refer to the block diagram in figure 4.)

- 3.1.1 UNIT FUNCTION DECODER READ/WRITE PCA.
- 3.1.1.1 The unit function decoder (U3) is a 1-of-10 decoder which determines whether the Read/Write PCA is in Read or Write mode. It also determines the CTU Transport from which flux transitions are received, or to which flux transitions are sent.
- 3.1.1.2 When RE and line USO are low, QO and Q1 are active outputs and Head 1 is driven by DATA as shown in the truth table below. When RE is low, and USO is high, Q2 and Q3 are active outputs and Head O is drven by DATA as shown below.

1 - Of - 10 Decoder (U3)
Truth Table

==	====:	====	=====	=====	===	=====	===:	====	====	====	====	==
1	1	NPUT	S	!	OUTPUTS							
	RE I	JSO I	DATA	00	01	02	Q3	04	Q5	Q6	Q7	
ī												1
1	1 L	L	LI	1 1L	H	H	Н	Н	Н	Н	Н	- 1
1	1 L	L	H I	I IH	L	H	Н	H	Н	Н	Н	١
1												1
١	l L	Н	LI	H	H	L	HI	Н	H	Н	Н	- 1
1	1 L	Н	HI	H	Н	I H	LI	H	Н	Н	Н	1
1				1								ı
1	1 H	L	LI	H	Н	Н	Н	L	HI	Н	Н	1
1	1 H	L	HI	H I	H	H	Н	1 H	LI	Н	В	1
1				1								ı
1	1 H	Н	LI	I H	Н	Н	H	Н	Н	L	HI	- 1
1	I H	Н	HI	H	Н	H	Н	Н	H	H	LI	ł
1				ł								1
==:	=====	====	=====	=====	====	====	===:	====	====	====	====	==

- 3.1.2 WRITE CURRENT CIRCUIT READ/WRITE PCA.
- 3.1.2.1 The write current circuit provides the current source for either head as selected by the unit function decoder. In addition, the RIP signal is generated allowing the firmware to determine whether a cartridge is protected.
- 3.1.2.2 When RE is low (write) U17, Pin 4 is high and Q15 turns on. This, in turn, drives Q16, the current source, on. When RE is high (read), U17, Pin 4 is low and Q15 is cut off which in turn cuts off Q16. The emitter current of Q16 is primarily determined by the +12 volts supply, R42, CR13, and is nominally 9.85 mA. When the current source (Q16) is off, the RIP driver (Q17) is turned on through R42, CR11, CR10, R44.
- 3.1.2.3 When the current source is on and supplying current to the head, the emitter of Q16 is at approximately +4.6 volts and CR11 isolates the base of Q17 from this voltage. The collector of Q16 is at a low voltage when any one of U3's outputs (Pins 1, 2, 3, or 4) is low, then CR12 removes the drive to the base of Q17 cutting it off. If the current source is on, and not supplying current to the head (i.e., the file protect switch is open, or the head leads are broken), the collector of Q16 is then connected to a high resistance path (CR12, R44, R49) and Q16 saturates causing most of its emitter current to flow out its base into Q15 and CR13 to ground. Then the collector voltage of Q16 which is now about the same as the emitter voltage, drives Q17 on through CR12 and R44. The two paths driving Q17 assure that RIP is true only when head current is actually drawn.
- 3.1.2.4 when recording data, however, RIP is not at a steady dc level. The head, being inductive, opposes an instantaneous current change. For a brief instant, at each current reversal, the -L(di/dt) is such that Q16 saturates and stays saturated until the rising current through the head reacnes a sufficient value to allow Q16 to come out of saturation. Since, as explained above, Q17 is triggered on and then Q16 is saturated, narrow negative going pulses, approximately 10 microseconds wide, appear at the RIP output. RIP is at a steady high level only when writing gaps.
- 3.1.3 READ SELECT SWITCH READ/WRITE PCA.
- 3.1.3.1 The read select switch (U16) is a FET switch used to connect the head on the selected CTU Transport Assembly with the preamp in the read amplifier circuit when the Read/Write PCA is in the Read mode.

3.1.3.2 Refer to the truth table in section 3.1.1.2 for a summary of the fol-

lowing. When RE is high (read) and USO is low (DATA is a don't care), Q4 and Q5 are tied together and go low. This drives U17, Pin 12 high turning switches 1 and 2 on and Head 1 is connected to the preamp.

when RE and USO are high (DATA is a don't care), 06 and 07 are tied together and go low. This drives U17, Pin 6 high turning switches 3 and 4 on and Head 0 is connected to the preamp.

- 3.1.4 READ AMPLIFIER CIRCUIT READ/WRITE PCA.
- 3.1.4.1 The read amplifier circuit amplifies the input signal from either head, differentiates the signal so that the peaks of the flux transitions become zero crossing, and then detects these zero crossings to produce a TTL signal with transitions at each zero crossings (flux transitions peak).
- 3.1.4.2 The preamp (U5) is a differential input/differential output op-amp. Its gain is determined by R39 and R40 plus the MUS switch on resistance in one leg, and by R38 and R41 plus the MOS switch on resistance in the other leg. The differential gain is 40dB. R38 and C36 on one side, and R39 and C39 on the other side, roll off the response starting at 30 kHz. C40 resonates the head at approximately 50 kHz, effectively compensating for some loss in the head output.
- 3.1.4.3 Differentiator (U4) is also a differential input/differential output op-amp. Its differentiating characteristics are determined by C21, R46, C16, and R34 in one leg, and by R47, C22, C19, and R35 in the other leg. Its gain at the two frequencies of interest (4 kHz and 8 kHz) is -2 dB and +4 dB, respectively. C21 with R46, and C22 with R47 stop its gain rise at +20 cB at 80 kHz; and R34 with C16, R34 with C16, R34 with C16, and R35 with C19 start its roll off at 160 kHz. The preamp outputs are connected to this differentiator which translates each amplitude peak of the preamp outputs to zero crossings.
- 3.1.4.4 The differentiator outputs are ac coupled at Pins 8 and 9 to comparator U1. The two inputs to U1 are lifted off ground and reference to +5V through R101F and R101G. This is necessary because this particular comparator must not have its inputs allowed to go below -0.3 Vdc. This comparator detects the zero crossings of the differentiator outputs and changes state each time, effectively squaring the differentiator output waveform. A small amount of nysteresis is used to assure that

the comparator output is at the correct polarity, i.e., low in the steady state (no data) and also to give it a snap action when a state change occurs. The positive feedback is derived from the output of U13, Pin 4. Since the comparator inputs are referenced to +5 volts, a level shifting is required and is accomplished by CR4, R33 and R32. In the high state, the output of U13, Pin 4 must be kept at a TTL level and CR4, R33 and R32 are also responsible for that. This voltage is +4.4 volts nominally. The +4.4 volts plus the CR4 Zener voltage make the voltage level at the junction of R33, R48, and CR4 equal to +10.6 volts. In the low state, the voltage at this junction is the CR4 voltage plus the low output voltage of U13, Pin 4 (or approximately +6.6 volts). Therefore at this junction, a rectangular wave exists between +6.6 volts and +10.6 volts. The hysteresis voltage is then derived from this through the R48, R101G divider. Nominally, Pin 8 of U1 is 32 millivolts positive with respect to Pin 9.

- 3.1.5 GAP DETECT CIRCUIT READ/WRITE PCA.
- 3.1.5.1 The gap detect circuit provides the GAP signal, which indicates the absence of flux transitions (if GAP is high) or the presence of flux transitions (if GAP is low). Whenever flux transitions begin or terminate, the GAP signal reflects this change after a delay of eight bit times.
- 3.1.5.2 A single output (U5, Pin 4) is also ac coupled to U1 at Pin 10, used here as a threshold detector. The two inputs of this comparator are referenced to +6 volts through R36 and R37. The threshold level is set by R103E and R37 and is nominally +0.057 volts, which is 15 per cent of the specified 1600 FRPI head output times the gain of the preamp. Pin 11 of U1 is +0.057 volts positive with respect to Pin 10. The output of U1, Pin 13 will change state every time the input to Pin 10 reaches this level, up or down. As a result, the output is not perfectly symmetrical, but has a duty cycle of approximately 45/55 at 1600 FRPI.
- 3.1.5.3 The output of U1, Pin 13 drives the integrator driver (018). R57, R58, and C45 together with U13, Pin 6 form the gap detector. U13, Pin 6 (a Schmitt-Trigger) triggers on at +1.7 volts and off at +0.9 volts. The time constants of the integrator are proportioned so that eight bit times at 1600 FRPI (or 1 millisecond) is required to reach the on level. This delay assures that the gap detect circuitry will not be triggered by random noise. Once U13, Pin 6 is on (output low) and data is received, GAP will be false. When data stops, C45 will begin to discharge through R58 and Q18; when its level reaches +0.9 volts, U13, Pin 6 will trigger off indicating beginning of gap. Nominally, this

time is also 1 millisecond. Therefore, GAP is true 1 millisecond after data stops until 1 millisecond into the next block. The output of U13, Pin 4 is connected to Pin 10 of U12 and the output of U13, Pin 6 is

connected to ΩR gate U12, Pin 9. This serves to quiet the DZX output during gap time.

- 3.1.6 TACHOMETER FEEDBACK SELECT AND CONDITIONING CIRCUITS READ/WRITE PCA.
- 3.1.6.1 The tachometer feedback select and conditioning circuits condition the inputs from the tachometers by filtering and by comparison and then select the signal from the tachometer associated with the CTU Transport that is selected.
- 3.1.6.2 The tachometer on the capstan drive motor is a variable reluctance type which produces a sine wave output of approximately 300 millivolts peak-to-peak at 10 inches per second tape speed. This signal is fed into the Read/Write PCA. The signal has a 0.027 microfarad (C2 and C4) filter capacitor shunting it to roll off the output of the tachometer above the frequencies of interest (4 kHz). A tach signal then drives a comparator (U1, Pin 6 or U1, Pin 4) with positive hysteresis (33 millivolts). NAND gates U11 select the signal TACH FREQ from the selected CTU Transport. This signal drives a delay circuit producing the DELAYED TACH signal.
- 3.1.7 AMPLIFIER SELECT LOGIC READ/WRITE PCA.
- 3.1.7.1 The amplifier select logic determines which motor is to be driven based upon which CTU Transport is selected.
- 3.1.7.2 If the RUNG signal is low, then 1SEL and 0SEL are high, inhibiting the motor drive circuitry. If RUNG is high, both gates of U11 in this block are enabled. If Unit 0 is selected (USO high) and a cartridge is inserted in Unit 0 (CINO high), then 0SEL will be low, selecting the CTU drive circuits associated with CTU Transport Unit 0. On the other hand, if Unit 1 is selected (USO low) and a cartridge is inserted in Unit 1 (CINI high), then 1SEL will be low, selecting the CTU drive circuits associated with CTU Transport Unit 1.

- 3.1.8 COMMAND RAMP AND FEEDBACK CIRCUITS READ/WRITE PCA.
- 3.1.8.1 The command ramp circuits translate command signals to move the tape fast forward, slow forward, fast reverse, and slow reverse into ramped voltages used by the CTU drive circuits. The feedback circuit provides a voltage directly proportional to the speed of the motor. The Feedback Voltage (FDBK VOLTAGE) and the Ramp Command Voltage (RAMP VOLTAGE) are summed to provide an error signal for the power amplifiers in the CTU drive circuits.
- 3.1.8.2 FFD, SFD, FREV and SREV run command lines drive open-collector TTL inverters which have 10 kilohm pullup resistors to a 10-volt Zener reference. Unly one input should be pulled low at any one time. These commands cause the servo to drive at +60, +10, -60 and -10 ips. Fast and slow command voltage values are determined by the relative values of R12 through R15. Reverse commands are inverted before being applied to the ramp circuit by op-amp U6 (all op-amps are dual internally compensated op-amp packages). The two op-amps (U8) make up the ramp circuit which together are analogous to a single inverting op-amp with a slow linear slew rate. The first half of the ramp circuit is a high gain (196K divided by 1 kilonm = 196) voltage driver which supplies bias current to a bidrectional voltage reference composed of CR5 and CR6. This reference voltage (approximately +/-6.9 volts) is supplied to the second op-amp operated as a Miller integrator and has a slew rate of 6.9 volts divided by R23, all divided by C27 (31 volts per second). R22 feeds back the output of the integrator which sets the dc gain of the ramp circuitry. The output for slow commands is +/-1.2 volts and for high speed commands is +/-7.2 volts.
 - Q3, Q4, U13, and op-amp U6 form a bidirectional threshold detector that indicates the polarity of the command voltage as well as the 1 ips (either forward or reverse) threshold of the ramp command voltage, generating the signals +FDBK EN and -FDBK EN.
- 3.1.8.3 The TACH FREQ and DELAYED TACH signals go into an exclusive-OR gate made up of U12 and two gates of U15. The output of the exclusive-OR gate is a pulse for every input transition, thus doubling the frequency of the tach signal. This double frequency signal drives a precision one-shot whose output (93 microsecond period) is fed to one of two TTL open-collector buffers (U10), depending on the desired feedback polarity. The feedback polarity is determined by the polarity of the command voltage. The +FDBK EN and -FDBK EN signals gate the one-shot output to the appropriate TTL buffer. One TTL buffer output is in-verted by the first half of U7, operated also as a 3 kHz low pass

filter. The filter integrates the pulses of the one-snot to help reduce the ripple on the feedback signal. Both tach feedback polarities are fed to the main 2-pole minimum phase Chebychev filter (2 poles at 200 Hz). This output is the servo Feedback Voltage (FDBK VOLTAGE). The Feedback Voltage waveform looks like the ramp command waveform with extra ripple riding on it. This is risidual digital tach ripple that is not filtered out by the 2-pole filter, but instead is filtered out by the mechanical pole of the motor drive.

- 3.1.9 CTU DRIVE CIRCUITS READ/WRITE PCA.
- 3.1.9.1 The CTU drive circuits use the error voltage generated at the summing junction as an input to the power amplifier determined by the selected CTU Transport driving the motor for that transport.
- 3.1.9.2 A 2-drive tape system has two dc servo motors which must be selectively driven. The selection of the motor to be driven is done at the low signal level using junction field effect transistors. Each power amp has two FETs associated with it. The first FET (Q6 or Q10) switches a power amp to the power amp summing junction. The R55 speed adjust potentiometer and R25 convert the Ramp Voltages (RAMP VOLTAGE) to command currents into the power amp summing junction. In addition, FDBK VOLTAGE is changed to a feedback current by R24 into the power amp summing junction. The second FET (Q5 or Q9) clamps the unused power amp off so that leakage currents cannot cause the non-selected motor to turn. The power amps are op-amps (U9) with high gain bipolar emitter followers (Q7 and Q8 or Q11 and Q12). The buffer power transistors are mounted on an aluminum heat sink.

The outputs of the power amplifiers are fed to the drive motors. The return side of the motors come through a current sensing resistor (R31). The motor current produces a voltage across this resistor which drives current limit detector transistors Q13 and Q14. They clamp the power amp through diode bridge CR8. C32 and C33 stabilize the current limit feedback loop. The current sense voltage also is used for compensation of the velocity feedback loop by locally characterizing the response of the power amp through R29, R28, C34 and C35 back to the power amp summing junction. This compensation gives the servo velocity loop a 55-hertz bandwidth (with typically 45 degrees phase margin and 12 dB gain margin).

- 3.1.10 CARTRIDGE DETECT CIRCUIT READ/WRITE PCA.
- 3.1.10.1 The cartridge detect circuit delays the CI signal from the CTU Transport allowing time for the CTU Transport to mechanically stabilize after a cartridge is inserted.

3.1.10.2 When a cartridge is inserted in Unit 1, the CI line is pulled low causing U17, Pin 8 to go high. This allows C3 to charge through R2 and R3. After approximately 1/2 second, Q2 turns on and pulls U13, Pin 1 low causing CIN1 to go high and indicating the presence of a cartridge. U13 is a Schmitt gate used to provide hysteresis so that the slow fall time of the collector Q2 will not cause oscillations at the output of U13.

when the cartridge is ejected from Unit 1, all actions of the signals are inverted with the exception of capacitor C3 which discharges only through R2 (C3 discharges 464 times faster than it charges when a cartridge is inserted). The analysis for Unit 0 cartridge insertion and ejection are similar, except that U17, Pin 10, R1, R50, C1, Q1, and U13, Pin 10 are involved in affecting the state of CINO.

FUNCTIONAL DESCRIPTION - CARTRIDGE ELECTRONICS PCA. Refer to the block diagram (figure 7), schematic diagram (figure 8), component location diagram (figure 9), and parts lists (02640-60034 and 02640-60066) located in the appendix.

The Cartridge Electronics PCA is a small PCA (part of the head bridge assembly of the CTU Transport) mounted to the tape mechanism's head mount. This assembly includes a 14-conductor ribbon cable which plugs into the Read/Write PCA. The ribbon cable provides all the electrical connections required by the mechanism, except motor current.

- 3.2.1 CI SWITCH CARTRIDGE ELECTRONICS PCA.
- 3.2.1.1 The Cartridge Inserted (CI) switch (S2) is activated by the presence of a cartridge in the mechanism. The information concerning the presence or absence of a cartridge is transferred to the firmware, which takes the appropriate action.
- 3.2.1.2 When a cartridge is inserted, contact is made between two pads on the Cartridge Electronics PCA. This action connects the CI line to ground.

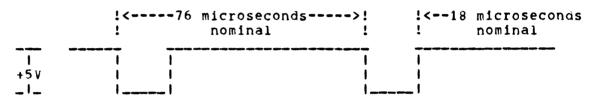
when a cartridge is not inserted, the CI line is pulled to +5 volts by a resistor on the Read/Write PCA. No "debouncing" circuitry is required since a delay is provided by circuitry on the Read/Write PCA.

- 3.2.2 FP SWITCH CARTRIDGE ELECTRONICS PCA.
- 3.2.2.1 The File Protect (FP) switch (S1) is activated when the RECORD tab on the cartridge is in the record position. This allows the user to inhibit accidental recording of data.
- 3.2.2.2 with the RECORD tab in the record position, contact is made between two pads on the Cartridge Electronics PCA. This contact allows current to flow through the center tap of the head which causes recording on the tape. If contact is not made then data may not be recorded on the tape, irrespective of whether or not the Read/Write circuitry is in the Write mode.
- 3.2.3 LAMP DRIVER CARTRIDGE ELECTRONICS PCA.
- 3.2.3.1 The lamp driver accepts the ground true Lamp (L) signal and drives the lamp used as an indicator for the user. The state of the lamp is controlled by the firmware.
- 3.2.3.2 The lamp driver circuit consists of DS1, R3, R12, and 1/2 of U1. When the output of U1 is in the high state (lamp off), R3 allows approximately 40 mA to flow through DS1. This current keeps the filament hot so that the lamp turn on surge current (155 mA) is less than twice the nominal current. When J2, Pin 9 is grounded, the output of U1 goes low applying approximately 3.5 volts across the lamp. R12 limits the current through DS1 to achieve longer lamp life.
- 3.2.4 HOLE DETECT CARTRIDGE ELECTRONICS PCA.
- 3.2.4.1 The hole detect circuitry consists of a pulse generator and diode driver and a detection circuit. The hole detect circuit detects the

holes in the tape and provides a ground true signal (HOLE) that is used in the determination of BOT, load point (LP), early warning (EW), and EOT. Holes are detected with an infrared emitting diode and a phototransistor. Most of the time the irradiance emitted by the diode is blocked by the opaqueness of the tape. When a hole moves in the path, the irradiance travels to the photo-transistor and activates it. The infrared emitting diode in the hole detect circuit is not on continuously, but is pulsed at approximately 13 kHz. By pulsing the diode, more output can be obtained with less average current and power dissipation.

The pulsed diode output is detected, shaped and fed into the monostable multivibrator (one-shot). The one-shot is retriggerable and its time out is slightly longer than the time period of 13 kHz. Therefore, the output of the one-shot will remain true as long as it receives an input of at least a nominal 13 kHz. By measuring the time that the one-shot's output remains true, it can be decided whether the detection circuit has seen a scratch, a normal hole, or the tape has run completely off the end. This technique eliminates ambient light problems.

3.2.4.2 The pulse generator consists of U2, R6, R7 and C2. The resistors and capacitor control the frequency and symmetry of the output. The frequency is 13.125 +/-1.5 kHz. The output of U2, Pin 3 has the following waveform.



- 3.2.4.3 C1, CR1, R1, R2, and 1/2 of U1 make up the diode driver. During the time that the output of U1 is high (off) C1 charges through R2. When the output of U1 goes low, C1 is discharged through R1 and CR1. R1 limits the current through CR1 and R2 isolates this low impedence path from the +5 volts. The peak current through infrared emitting diode (CR1) is approximately 200 mA, and should provide a beam power output (minimum, peak) of 2.5 milliwatts.
- The detection circuit consists of Q1, Q2, Q3, CR2, U3, R4, R5, R8, R9, 3.2.4.4 R10, and C4. Irradiance striking its base region causes current to flow through Q1. Most of this current flows through Q3 and into the base of Q2. Q2 saturates, providing a negative transition which initiates the time out of the one-shot multivibrator, U3. R5 and CR2 provide a dc level to the base of Q3 that will allow the collector of Q3 to overcome the V(BE) of Q2. R5 also keeps the capacitance of CR2 and Q3 charged allowing faster circuit response. CR2 and Q3 provide a low impedence load to the photo-transistor Q1, which has a high C(be) thus also increasing response time. R4 sets the threshold of the detector circuit. Q1 must provide enough current to raise the voltage drop across R4 above the V(BE) of Q2 before Q2 will turn on. R9 is the collector load for Q2 and provides current for the inputs of U3 in their high state. R10 provides a high state for the other inputs of U3. R8 and C4 are the timing components for the monostable multivibrator U3. The time out is 110 +/-20 microseconds. R11 provides approximately 5 to 10 per cent positive feedback giving the detection circuit a Schmitt-trigger characteristic. This provides a more definite detection of the hole edges.

FUNCTIONAL DESCRIPTION - CTU TRANSPORT ASSEMBLY. Refer to the exploded view of the CTU Transport Assembly (figure 10), mounting provisions (figure 11), cartridge outline (figure 12), and the parts lists (02640-60050, 02640-60054, 02640-60055, 02640-60056, 02640-60057, 02640-60067, 02640-60074, 02640-60076, 02640-60085, and 02640-60102) located in the appendix.

The CTU Transport Assembly consists of a single major assembly which fastens to the terminal mainframe with two captive screws. Each drive has a signal cable and a motor cable connecting the drive to the Read/Write PCA. In addition, a special bezel covers the front of the terminal mainframe with openings for each drive. The spring loaded doors on the openings for the cartridges provide finish for the unit and protection for the drives.

Three major sub-assemblies make up the transport assembly—the base assembly, the head-bridge assembly and the motor/tachometer assembly. Each of these sub-assemblies is designed to be seperately replaceable without either special tools or adjustments. Figure 10 shows an exploded view of the CTU Transport.

- 3.3.1 BASE ASSEMBLY CTU TRANSPORT ASSEMBLY.
- 3.3.1.1 The base assembly provides the support structure for the drive.
- 3.3.1.2 The base assembly is mounted to the terminal using two 5/16 inch well nuts and two number 6-32 screws. The wall thickness at the mounting surface should be >/= 12 gauge for metal or other material. The well nuts with associated screws provide convenient captive fasteners. More importantly, they attenuate mechanical vibrations in the 1 kHz region and above. Without this attenuation, sharp impacts to the terminal could cause read or write errors. A third mounting surface, faced with a rubber pad, is used for location and stabilization of the drive.

In the normal mounting attitude the cartridge is held at 15 degrees to the horizontal. Other mounting positions may be possible but care should be taken to avoid having the head surface facing upwards to collect dirt. Also the eject spring may have to be changed for other mounting attitudes. Provision has been made in the tooling die for the base for an alternate 0 degrees mounting attitude; however, this has not yet been implemented in an optional product. Mounting dimensions and an outline of the mechanism are shown in figure 11. An outline of the cartridge is shown in figure 12.

To prevent loss of intimate tape-head contact due to insufficient wrap and to minimize head and tape wear due to excessive wrap, the base

assembly has registration surfaces which control the fore and aft position of the cartridge. These surfaces are accurate to within +/-0.001 inch with respect to locating pin holes on the base. These holes in turn determine the position of the head bridge assembly. Side-to-side location of the cartridge, a less critical registration, is accomplished by maintaining minimum clearance between the cartridge and the drive.

3.3.1.3 The base assembly also includes a latching and release mechanism which is actuated by a release button. This button is made of green transparent plastic so that it also acts as a light pipe to bring the light from an indicator lamp on a circuit board at the rear of the drive to the surface of the button. This eliminates the cost and complexity of a separate indicator on the bezel. The cartridge is inserted by pushing it in against the spring loaded latch mechanism.

Four rollers provide the locating force. Two rollers press against the corner of the notch in the cartridge base at about 45 degrees resulting in an upward force component. The other two rollers press straight up holding the cartridge against the locating planes in the base. A force of about 4 pounds is required to insert the cartridge. The retention force is over 3 pounds.

Pressing the button releases the latch taking the pressure off the four rollers and allowing the cartridge to pop out to a detent position for easy removal. The cartridge is ejected part way by the motor assembly swinging forward. At this point the ejector rises out of the base and continues the cartridge motion out to the detent position. In this manner, the ejection force does not oppose the latching force when the cartridge is fully inserted. The mechanism resets itself during the ejection and is then ready to accept a cartridge again. The detent action is effected by a pawl which is spring loaded against the cartridge by the same spring that returns the release button.

- 3.3.2 HEAD BRIDGE ASSEMBLY CTU TRANSPORT ASSEMBLY.
- 3.3.2.1 The head bridge assembly provides the critical reference surfaces for head-to-tape positioning and provides mounting for the Cartridge Electronics PCA.
- 3.3.2.2 The head bridge assembly has three pads which contact three small areas on the reference surface of the cartridge. This defines a reference plane both for the cartridge and the drive. The magnetic head is adjusted for both tilt and azimuth with respect to this plane as part of the manufacturing process. The head itself has a ball socket which engages a spherical "bump" molded into the plastic head bridge. Since the socket is centered on the magnetic gap in the head, the tilt and

azimuth adjustments are independent of one another. The vertical head position is controlled by maintaining close tolerances on the head and head bridge, and thus no height adjustment is required. The spherical bump is also within +/-0.001 inch with respect to the locating pins molded into the head bridge. This accurately controls the fore and aft position of the head to maintain the proper tape-head wrap angle. Once set, the head adjusting screws are sealed in position and no further head adjustment is required either at initial assembly or during field replacement. Thus any head bridge assembly works interchangeably with any base assembly.

- 3.3.2.3 The head bridge assembly also includes the Cartridge Electronics PCA (detailed in section 3.2) which performs various functions. Circuitry for sensing the position holes in the tape is included on this board. The infrared LED light source for this function is retained and precisely positioned by a molded-in clamp taking advantage of the strength and dimensional stability of the plastic material used in the head bridge to grip the LED without additional parts or machining. Cartridge insertion and the position of the RECORD tab on the cartridge are sensed by the position of two switches. Fixed contact pads for these switches are on the circuit board while the moveable contacts with their plunger actuators are enclosed within the head bridge giving inexpensive, reliable, enclosed switches.
- 3.3.2.4 The indicator lamp (previously mentioned) is also located on this PCA and is enclosed by a shield molded of titanium-dioxide filled plastic for maximum reflectivity. This part serves the dual functions of blocking stray light from the lamp while concentrating the light entering the light pipe portion of the release button. Since all interconnections are made on the board, no wiring harness is necessary on the mechanism.
- 3.3.3 MOTOR/TACHOMETER ASSEMBLY CTU TRANSPORT ASSEMBLY.
- 3.3.3.1 The third subassembly of the CTU Transport is the motor/tachometer assembly which consists of a motor with drive capstan, a motor mount and a tachometer to provide velocity feedback to the servo.
- 3.3.3.2 The motor/tachometer assembly is single axis gimballed about its center of gravity to eliminate acceleration effects on the force developed between the motor capstan and the belt capstan in the cartridge. This force is provided by two extension springs which also serve to retain the assembly in the gimbal and to aid in ejecting the cartridge. The force between capstans is 15 +/-1.5 ounces. The gimbal consists simply of two hemispherical ball and socket joints between the motor/tachometer assembly and the base assembly. The assemblies are held together

by two extension springs which also provide the correct capstan force. The right hand ball and socket set prevents translation while the left set has an elongated socket to prevent rotation about two axes without causing binding due to tolerance accumulations.

As well as retaining the motor/tachometer assembly in its gimbal, the two extension springs load the motor capstan against its mating belt capstan within the cartridge. This spring loading takes up an accumulation of dimensional tolerances within both the cartridge and the drive while holding the force between the capstans within specified limits. The motor capstan is a polyurethane elastomer covered aluminum part 0.338 inches in diameter. The elastomer used has the best combination of high coefficient of friction, resistance to compression set and resistance to wear of a selection of potential materials which were tested. The capstan is set-screwed to the motor shaft and its height can be set without special tools or fixtures. A variable reluctance tachometer is mounted to the motor/tachometer assembly. This consists of a 48-tooth disc staked to the motor capstan, a pickup coil and permanent magnetic flux gate assembly screwed to the motor mount. The disc-to-pickup distance is set at 0.012 inches +/-0.002 inches. Motor capstans with disc attached can be field replaced without need for further adjustment.

3.4 FUNCTIONAL DESCRIPTION - TAPE CARTRIDGE. Refer to the tape cartridge diagram (figure 13), hole status format (figure 14), and valid recording area (figure 15) located in the appendix.

The tape cartridge shown in figure 13 provides 120,000 bytes of storage in 256-byte record, single-track 0.130 +/-0.005 inches, 800 BPI (1600 FRPI) +/-60 BPI standard format. At 10 ips, this gives a typical burst rate of 1000 bytes per second and 748 bytes per second average throughput. The cartridge consists of a metal base plate and plastic cover.

The tape contains 140 feet (minimum) of 0.150-inch 8138 computer tape suitable for recording purposes. The tab labeled RECORD is used to enable recording on the cartridge. A cartridge door is used to protect the tape during transport and storage. When the cartridge is inserted into the CTU Transport Assembly, the door is opened automatically. The mirror is used with the hole sense scheme. An infrared emitter located in the CTU Transport Assembly base shines through the base plate onto the mirror. Light is then reflected through the front of the cartridge to a photo-sensor in the CTU Transport Head Bridge Assembly. The light is intercepted by the tape normally indicating no hole. If a hole is present the light will be detected by the photo-sensor. The motor capstan drives the belt capstan which then moves the cartridge tape via the belt. The belt consists of an elastomeric belt which drives the tape by transmitting the belt capstan force to both tape reels. The tape cleaner consists of a scraper which is displaced approximately 1.125 inches in front of the head.

- 3.4.1 HOLE STATUS FORMAT. The positioning of holes in the cartridge tape and the duration of the signal from the hole detect circuitry on the Cartridge Electronics PCA is shown in figure 14.
- 3.4.2 INTERCHANGE STANDARDS. The code, format of the encoded data, and the region of valid recording area on the 3M 9585 mini cartridge should be as follows in order to facilitate product interchange.

VALID RECORDING The portion of the tape where data may be recorded is shown in figure 15.

FILES There may be 1 to 344 files per cartridge.

BYTES Recording is bit serial, eight bits to a byte, LSB to MSB.

RECORDS

Records are variable in length and may contain from 12 to 267 bytes. There may be 444 to 517 records of of maximum length per cartridge.

RECORD URGANIZATION:

Preamble (3) bytes octal zero followed by (1) byte octal 200

Header (2) bytes to define binary length of record (most significant byte first).

Body 1 to 256 data bytes.

Checksum 1 byte binary addition modulo 256.

Postamble The postamble is (1) byte octal 1 followed by (3) bytes octal zero.

INTER-RECORD GAPS:

Length 0.805" min., 0.905" max., 0.88 nominal.

Polarity The IRG shall magnetize so that the beginning of the tape is a north seeking pole. NOTE: There are 0.01712 +/-0.0003" of tape travel for each detected edge.

FILE MARKS

Files shall be separated by a unique length gap and record as follows: 1.61" min., 1.81" max. gap followed by a 1.61" min., 1.81" max. gap.

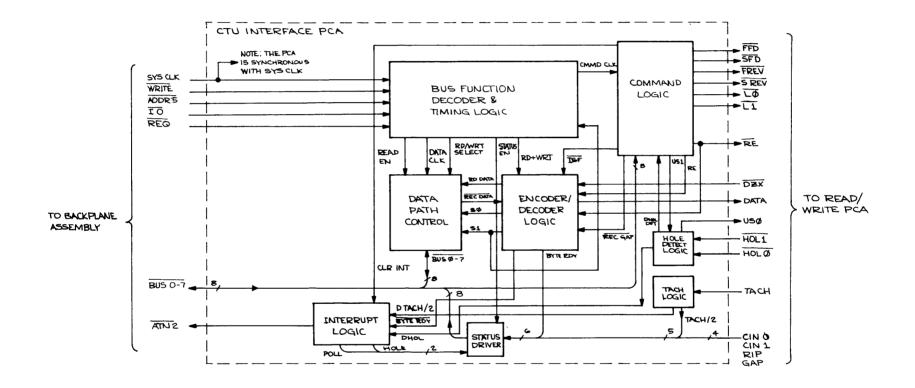
NOTE: The file mark record header is unique insofar as the most significant byte is always a "1".

END OF VALID DATA MARK A file mark followed by a gap of 11 +/-0.5"

3.4.3 MECHANICAL SPECIFICATIONS.

The mechanical characteristics of the cartridge are summarized in the following table:

=		
!	Speed	0 to 90 inches per second (maximum)
!	Drive ratio (tape velocity to the surface of the belt capstan)	0.78 +/-0.02
	Average short term tape speed variations at 10 ips (flutter)	+/-4% maximum with head inserted and excluding drive system variations
	Maximum acceleration	2 2000 in./sec from 0 to 90 ips
 	Tangential driving force of belt capstan to maintain constant operating speed	1.0 to 4.0 ounces
	Total equivalent inertial mass of all cartridge moving elements	-4 2 6 x 10 oz. sec /in. (in linear) units referred to the outer surface of the belt capstan)
1	Radial load to belt capstan	15 ounces +/-1.5 ounces
1	Dynamic tape tension (measured at constant drive speed)	0.5 to 2.0 ounces between tape guides exclusive of the effect of tape head
-		



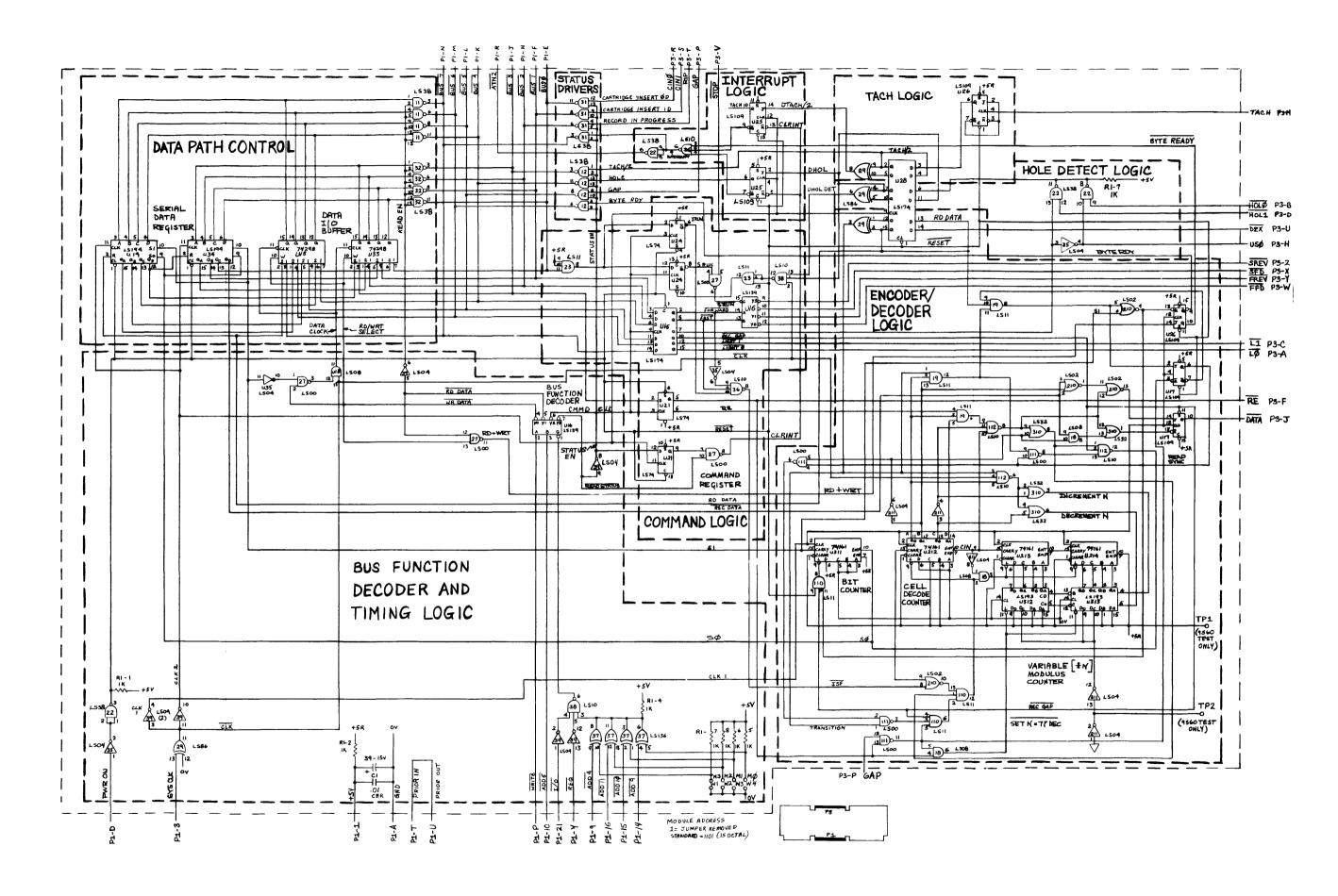
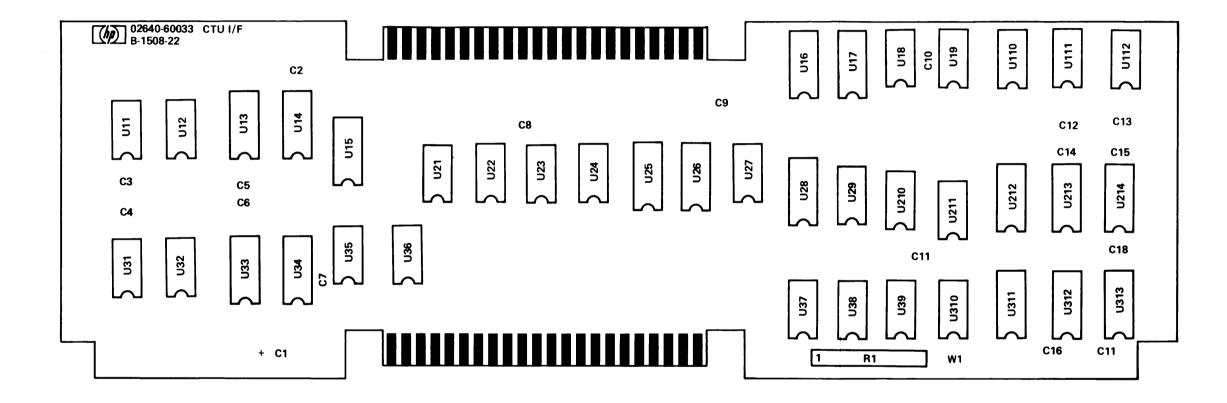
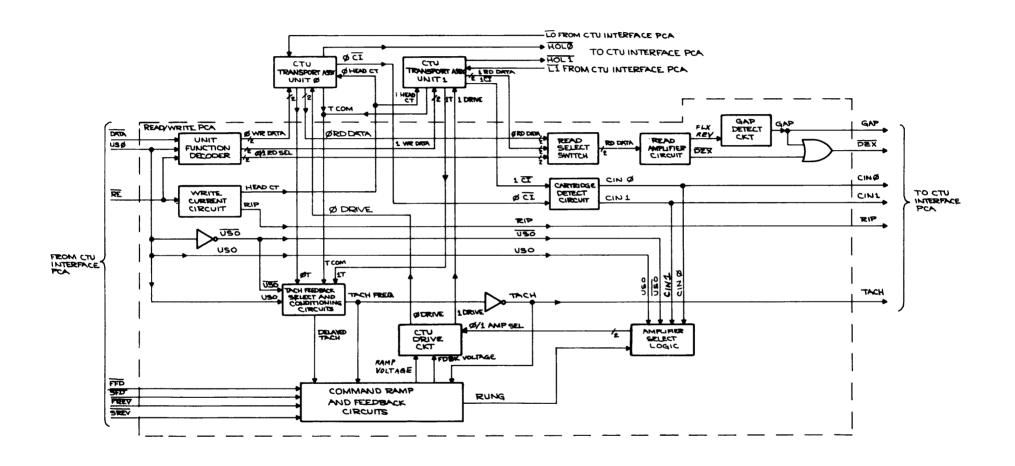


Figure 2 CTU Interface PCA Schematic Diagram AUG-01-76 13255-91032





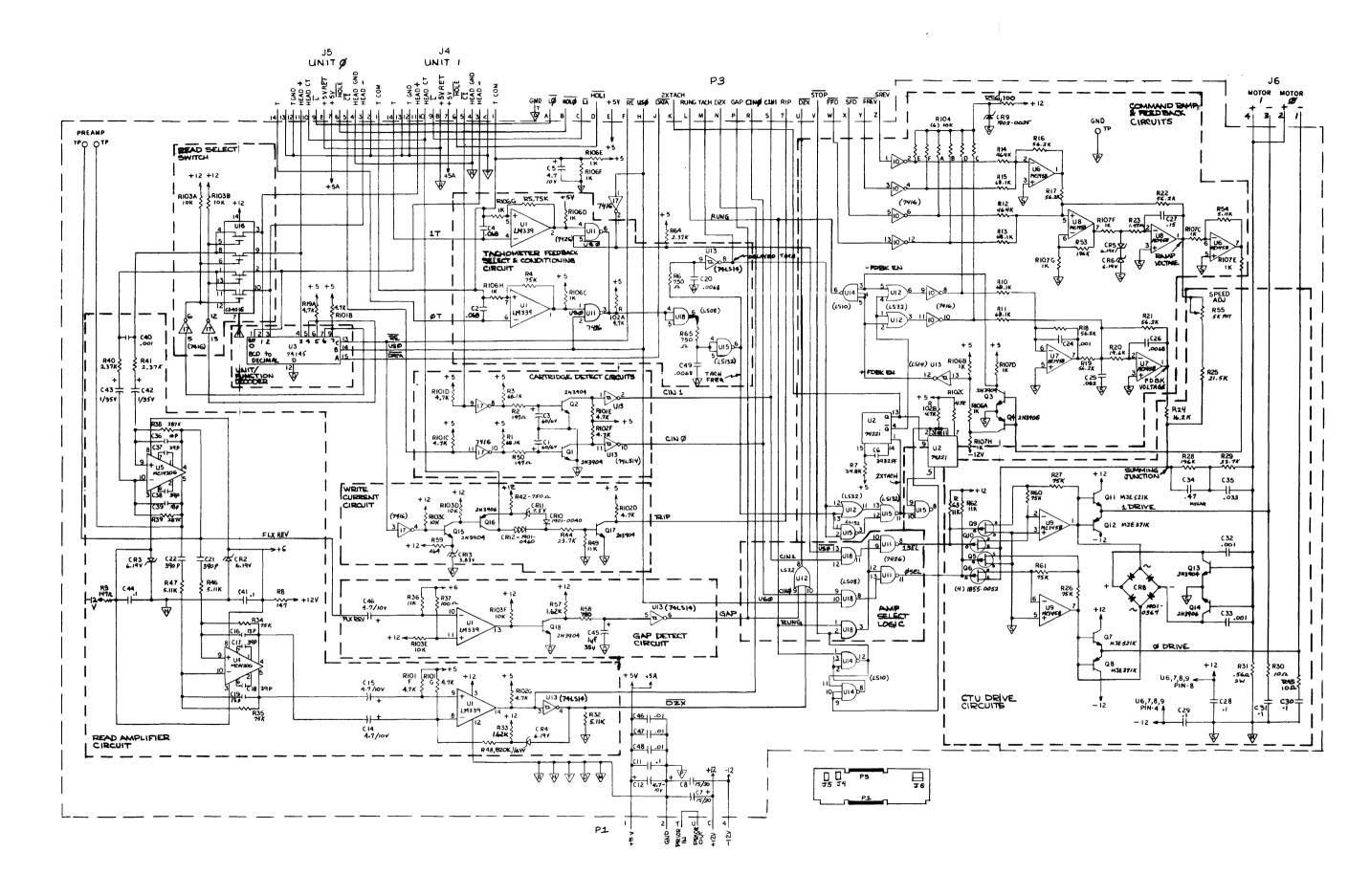
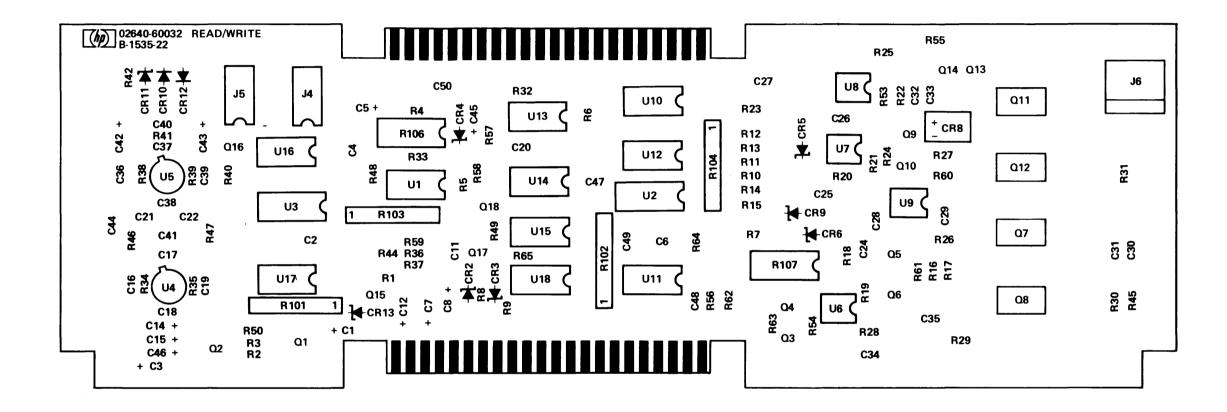
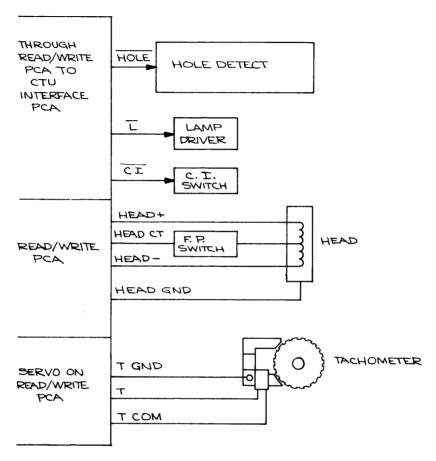


Figure 5
Read/Write PCA Schematic Diagram
AUG-01-76
13255-91032



CARTRIDGE ELECTRONICS PCA



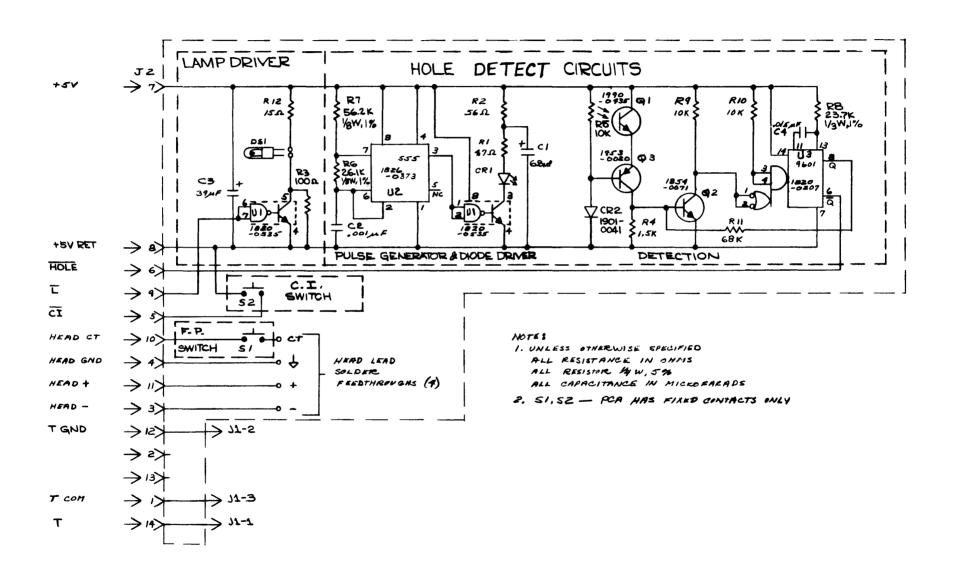
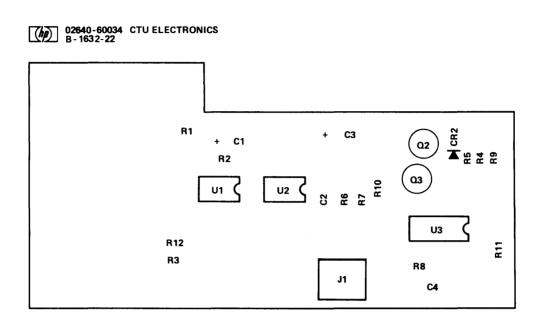
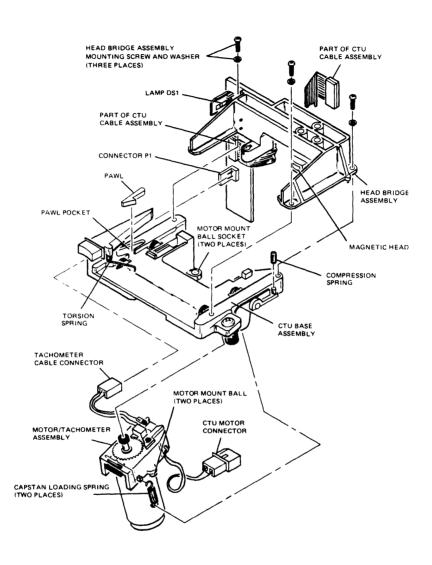


Figure 8
Cartridge Electronics PCA Schematic Diagram AUG-01-76
13255-91032





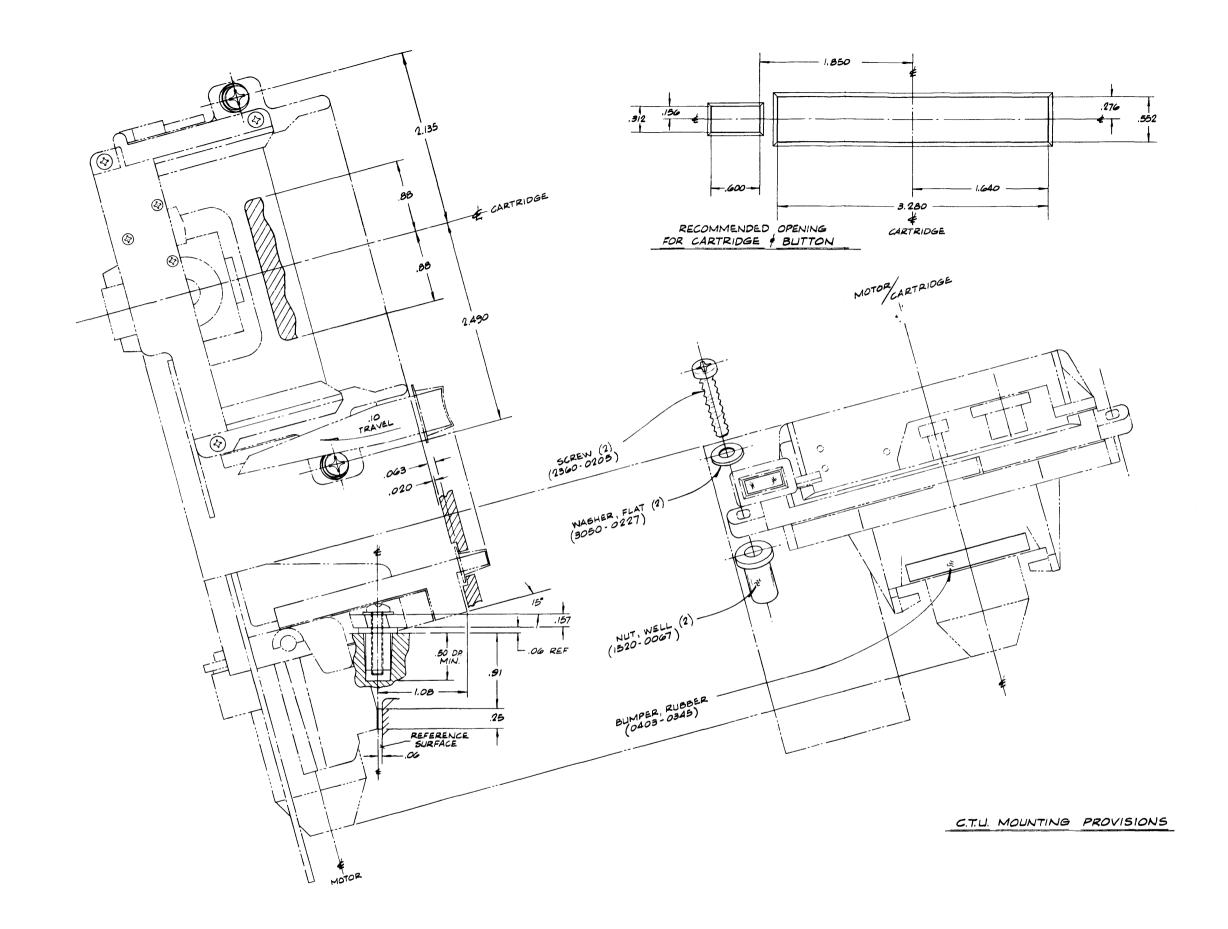
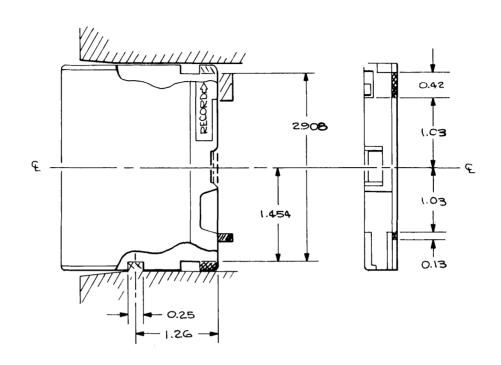
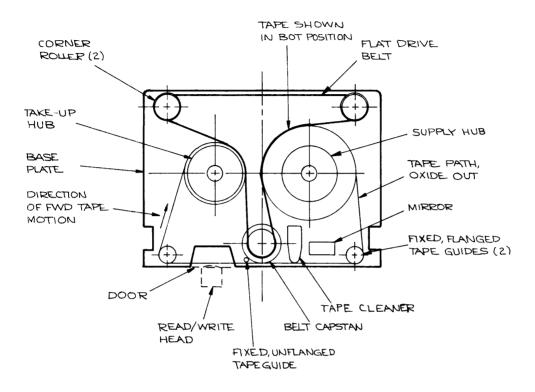
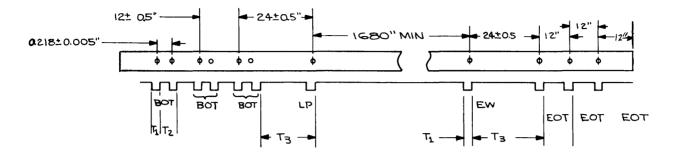


Figure 11 CTU Mounting Provisions Diagram AUG-01-76 13255-91032





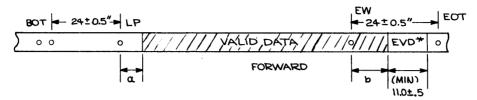


- •BOT = BEGINNING OF TAPE (2 CONSECUTIVE HOLES) (3 PAIR BOT HOLES
- •LP = LOAD POINT (1 HOLE)
- •EW = EARLY WARNING (1 HOLE)
- EOT = END OF TAPE (1 HOLE) (3 EOT HOLES)

USING THE HOLE STATUS FROM THE CTU TRANSPORT ASSEMBLY, THE HOLE TIMING IS AS FOLLOWS;

SPEED	T1		T ₂		Τ,	3
	MIN	XAM	MIN _	XAM	MIN	KAM
9-11 IPS	2,53 ms	8.57ms	11.23 ms	25,2ms	2,12 sec	2.7 sec
56-64 IPS	0.577ms	1.49 ms	1.92ms	3.9ms	353 ms	450ms

HOLE STATUS FORMAT



a)0.55 INCHES BEHIND LP MIN. b) 5.50 INCHES BEHIND EW MAX.

* EVD = END OF VALID DATA GAP

NOTE; THE READ/WRITE HEAD IS DISPLACED FROM
THE HOLE DETECTOR BY APPROXIMATELY 1.5 INCHES
& FROM THE TAPE CLEANER BY APPROXIMATELY
1.125 INCHES

Deference	Defended to the Desert Laborate Turis					
Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number	
	02 640-60021	1	CONNECTOR ASSEMBLY, (2) REVISION DATE: 03-26-76	28480	02640-60021	
	04C3-0347 1251-1887	2 2	BUMPER FOOT, 0.25" W CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	13862 71785	9668 252-22-30-340	
	i					
}				:		
		:				
				,		
L	L	L		L		

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	02 640-60054	1	CTU BASE ASSEMBLY	28480	02640-60054
	0463-0253 0510-0052 0624-0333 1460-1382 1460-1411	1 1 2 1	REVISION DATE: 06-19-76 BUMPER FOOT RETAINER-RING .125-DIA STL CD-PL SCREW-IPG 4-20 .25-IN-LG PAN-HD-POZI STL WIREFORM .16-IN-W 1.42-IN-LG MUW SPRING-EXT .12-IN-DO .75-IN-LG MUW CD	00000 97464 28480 28480 28480	OBD 7100-12-CD 0624-0337 1460-1382 1460-1411
	1460-1455 4040-0998 4040-1012 4040-1095 02640-20006	1 1 1 1 4	SPRING-TRSN MUM CD BUTTON RELEASE BASE LEVER RELEASE ROLLER, LATCH	28480 00315 28480 28480 28480	1460-1455 C-4040-8998-1 4040-1012 4040-1095 02660-20006
	02640-40017 02640-40018 02640-40019	1 1 1	CLAMP, BUTTON EJECTOR BEZEL, BUTTON	28480 28480 28480	02640-40017 02640-40018 02640-40019
			,		

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	02 440- 60057	1	TACHOMETER COIL ASSEMBLY REVISION DATE: 05-19-76	28480	02640-60057
	0342-0505 121-0670 1251-3201 8150-2353 9100-0648	1 3 1	TERMINAL-CRIMP TNG-R #2 26-22-ANG CUNTACT-EGNN U/M-POST-TYPE FEM CRP CONNECTOR 3-PIN F POST TYPE WIRE 24ANG N 300V PVC 7X32 80C COIL,TACH 2400+/-100 TURNS	28480 27264 27264 28480 28984	0362-0505 08-50-0105 09-50-7031 8150-2353 NO. 43 AMG
		;			

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	02640-60067	1	HEAD ASSEMBLY REVISION DATE: 03-13-76	28480	02640-60067
	0624-0337 1400-0249 1460-1383 3050-0675 4040-1013	3 1 2 1 1	SCREM-TPG 2-56 .5-IN-LG PAN-HD-TORX STL CABLE TIE .062625-DIA .091-WD NYL SPRING-CPRSN .18-IN-DD .312-IN-LG MUW GD WASHER-FL MILC NG2 .089-IN-IC HEAD, MOUNT	93907 59730 84830 86928 28480	235-02020-012 TYB-23M-8 LC-0268-2-NW. 5712-156-32 4040-1013
	9164-0061	1	HEAD- CART TAPE	28480	9164-0061
			•		
	:				
	:				

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	02 640-60074	1	MAGNET ASSEMBLY REVISION DATE: 03-13-76	28480	02640-60074
	0470-0515 1530-1780 9160-0240	2 1	ADHESIVE, ABLESTIK 293-1T EPOXY 1-PART POLE PIECE MAGNET	21109 28480 28480	293-11 1530-1780 9160-0240
		İ			

Defenses Up Port Major					
Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	02 640-60076	1	DISC/CAPSTAN ASSEMBLY REVISION DATE: 03-13-76	28480	02640-69076
	1530-1781	1 1		28480	1530-1781
	1530-1781 1600-0491 3030-0142	2	MOTOR, CAPSTAN DISC, TACH872" DIA SCREW-SET 2-56 .125-IN-LG SMALL CUP-PT	28480 28480	1530-1781 1600-0491 3030-0142

•

Deferrer	Replaceable Paris					
Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number	
	02 640-60085	1	MOTOR CABLE ASSEMBLY REVISION DATE: 03-13-76	28480	02640-60085	
	0850-0006 1251-0670 1251-2505 1251-2600 1251-3277	4 2 4 1	TUBING-FLEX .204-ID PVC .02-MALL CONTACT-CONN U/M-POST-TYPE FEM CRP CONNECTOR 2-PIN F UTILITY CONTACT-CONN FEM CRP .093-IN-CCNT-SZ CONNECTOR 4-PIN F POST TYPE	96904 27264 27264 27264 27264	400/461 FR-1 08-50-0105 03-09-1022 02-09-1116 09-50-7041	
	8150-1540 8150-1542 8150-1550 8150-1552		MIRE 22AMG BK 300V PVC 7X30 80C MIRE 22AMG R 300V PVC 7X30 80C MIRE 22AMG W/BK 300V PVC 7X30 80C MIRE 22AMG W/R 300V PVC 7X30 80C	28480 28480 28480 28480	8150-1540 8150-1542 8150-1550 8150-1552	
·						

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	02 640-60032	1	READ/WRITE ASSEMBLY	28480	02640-60032
ćī.	0180-0106	2	DATE CODE: 8-1535-22 REVISION DATE: 08-06-76 CAPACITOR-FXD 60UF20% 6VDC TA	56289	1500606X0006B2
62 63 64 65	0160-0166 0180-0106 0160-0166 0160-0309	2 5	CAPACITOR-FXD .068UF +-10% 200MVDC POLYE CAPACITOR-FXD 60UF+-20% 6VDC TA CAPACITOR-FXD .068UF +-10% 200MVDC POLYE CAPACITOR-FXD 4.7UF+-20% 10VDC TA	56289 56289 56289 56289	292P68392 150D606X000682 292P68392 150D475X0010A2
C6 C7 C8 C11 C12	0140-0161 0180-1746 0180-1746 0150-0121 0180-0309	1 2 7	CAPACITOR-FXD 3932PF +-1% 300WVDC MICA CAPACITOR-FXD 15UF+-10% 20VDC TA CAPACITOR-FXD 15UF+-10% 20VDC TA CAPACITOR-FXD .1UF +80-20% 50WVDC CER CAPACITOR-FXD 4.7UF+-20% 10VDC TA	72136 56289 56289 28480 56289	DM20F3932RFQ300WV1CR 1500156X9Q2QB2 1500156X9Q2QB2 0150-0121 1500475XQQ1QA2
014 015 010 017 018	0180-0509 0180-0309 0160-2260 0140-0190 0140-0190	2	CAPACITOR-FXD 4.7UF+-20% 10VDC TA CAPACITOR-FXD 4.7UF+-20% 10VDC TA CAPACITOR-FXD 13PF +-5% 50UNVDC CER CAPACITOR-FXD 39PF +-5% 300UVDC MICA CAPACITUR-FXD 39PF +-5% 300UVDC MICA	56289 56289 28480 72136 72136	1500475X0010A2 1500475X0010A2 0160-2260 DM15E390J0300W1CR DM15E390J0300W1CR
C19 C20 C21 C22 C24	0160-2260 0160-0159 0140-0200 0140-0200 0160-0153	3 2 4	CAPACITOR-FXD 13PF +-5% 500WVOC CER CAPACITOR-FXD 6800PF +-10% 200WVDC POLYE CAPACITOR-FXD 390PF +-5% 300WVDC MICA CAPACITOR-FXD 390PF +-5% 300WVDC MICA CAPACITOR-FXD 1000PF +-10% 200WVDC POLYE	28480 56289 72136 72136 56289	0160-2260 292P68292 DM15F391J03300WV1CR DM15F391J0390WV1CR 292P10292
C25 C26 C21 C2d C29	0140-0167 0160-0159 0160-3238 0150-0121 0150-0121	1	CAPACITOR-FXD .082UF +-10% 200HVDC POLYE CAPACITOR-FXD 6800PF +-10% 200HVDC POLYE CAPACITOR-FXD .15UF +-5% 200HVDC POLYE CAPACITOR-FXD .1UF +80-20% 50HVDC CER CAPACITOR-FXD .1UF +80-20% 50HVDC CER	56289 56289 56289 28480 28480	292P82392 292P68292 292P15452 0150-0121 0150-0121
130 131 132 133 134	0150-0121 0150-0121 0160-0153 0160-0153 0160-0970	1	CAPACITOR-FXD .1UF +80-20% 50WVDC CER CAPACITOR-FXD .1UF +80-20% 50WVDC CER CAPACITOR-FXD 10000F +-10% 200WVDC POLYE CAPACITOR-FXD 10000F +-10% 200WVDC POLYE CAPACITOR-FXD .47UF +-10% 80WVDC POLYE	28480 28480 56289 56289 28480	0150-0121 0150-0121 292P10292 292P10292 0160-0970
035 036 037 038 039	0160-0163 0160-2263 0140-0190 0140-0190 0160-2263	1 2	CAPACITOR-FXD .033UF +-10% 20UMVDC POLYE CAPACITOR-FXD 18PF +-5% 500MVDC CER CAPACITOR-FXD 39PF +-5% 300MVDC MICA CAPACITOR-FXD 39PF +-5% 300MVDC MICA CAPACITOR-FXD 18PF +-5% 500MVDC CER	56289 28480 72136 72136 28480	292P33392 0160-2263 DM15E390J0300WV1CR DM15E390J0300WV1CR 0160-2263
(40 041 042 043 044	0160-0153 0150-0121 0160-0291 0160-0291 0150-0121	3	CAPACITOR-FXD 1000PF +-10% 200MVDC POLYE CAPACITOR-FXD .1UF +80-20% 50MVDC CER CAPACITOR-FXD 1UF+-10% 35VDC TA CAPACITOR-FXD 1UF+-10% 35VDC TA CAPACITOR-FXD .1UF +80-20% 50MVDC CER	56289 28480 56289 56289 28480	292P10292 0150-0121 150D105X9035A2 150D105X9035A2 0150-0121
L45 L46 C47 L43 L49	0160-0291 0160-0309 0160-2055 0160-2055 0160-0159	3	CAPACITOR-FXD 1UF+-10% 35VDC TA CAPACITOR-FXD 4.7UF+-20% 10VDC TA CAPACITOR-FXD -01UF +80-20% 100WVDC CER CAPACITOR-FXD -01UF +80-20% 100WVDC CER CAPACITOR-FXD 6800PF +-10% 200WVDC POLYE	56289 56289 28480 28480 56289	1500105X9035A2 1500475X0010A2 0160-2055 0160-2055 292P68292
ÇSÜ	0160-2055		CAPACITOR-FXD .01UF +80-20% 100WVDC CER	28480	0160-2055
CR2 CR3 CR4 CR5 CR0	19 C2-0049 19 C2-0049 19 C2-0049 19 C2-0049 19 C2-0049	5	DIODE-ZNR 6.19V 5% 00-7 PD=.4H TC=+.022%	28480 28480 28480 28480 28480	1902-0049 1902-0049 1902-0049 1902-0049 1902-0049
CK3 CR9 CK10 CR11 CK12	19C1-0364 19C2-0025 19C1-0040 19C2-0064 19C1-0460	1 1 1 1	DIODE-FN BRDG 200V 1A DIODE-ZNR 10V 5% DD-7 PD=.4M TC=+.06% DIODE-SWITCHING 30V 50MA 2NS DD-35 DIODE-ZNR 7.5V 5% DD-7 PD=.4M TC=+.05% DIODE-STABISTOR 15V 150MA DO-7	04713 28480 28480 28480 28480	SDA 10185-4 1902-0025 1901-0040 1902-0064 1901-0460
CR13	1902-3059	1	DIODE-ZNR 3.83V 5% DG-7 PD=.4W TC=051%	15818	CD 35586
E1 E2 E3	0340-0124 0340-0124 0340-0124	3	TERMINAL-STUD SGL-PIN PRESS-MTG TERMINAL-STUD SGL-PIN PRESS-MTG TERMINAL-STUD SGL-PIN PRESS-MTG	28480 28480 28480	0360-0124 0360-0124 0360-0124
J4 J5 J6	12C0-0474 12C0-0474 1251-3873	2	SOCKET-IC 14-CONT DIP-SLOR SOCKET-IC 14-CONT DIP-SLOR CONNECTOR 4-PIN M POST TYPE	28480 28480 27264	1200-0474 1200-0474 09-88-2041
01 02 03 04 05	1854-0215 1854-0215 1854-0215 1853-0036 1855-0052	7 3 4	TRANSISTOR NPN SI PD=350MW FT=300MHZ TRANSISTOR NPN SI PD=350MW FT=300MHZ TRANSISTOR NPN SI PD=350MW FT=300MHZ TRANSISTOR PNP SI PD=310MW FT=250MHZ TRANSISTOR MCSFET P-CHAN D-MUDE TO-92 SI	04713 04713 04713 28480 07263	SPS 3611 SPS 3611 SPS 3611 1853-0036 ZN4360

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
46 97 98 99	1855-0052 1854-0653 1853-0369 1855-0052 1855-0052	2 2	READ/WRITE ASSEMBLY CONT'D. TRANSISTOR MGSFET P-CHAN D-MODE TO-92 SI TRANSISTOR NPN SI PD=60W TRANSISTOR PNP SI PD=60W TRANSISTOR MGSFET P-CHAN D-MODE TO-92 SI TRANSISTOR MGSFET P-CHAN D-MODE TO-92 SI	07263 04713 04713 07263 07263	2N4360 MJE521K MJE371K 2N4360 2N4360
Q11 Q12 Q13 Q14 Q15	1854-0653 1853-0369 1854-0215 1853-0036 1854-0215		TKANSISTOR NPN SI PD=60W TRANSISTOR PNP SI PD=60W TRANSISTOR NPN SI PD=350MW FT=300MHZ TRANSISTOR NPN SI PD=310MW FT=250MHZ TRANSISTOR NPN SI PD=350MW FT=300MHZ	04713 04713 04713 28480 04713	MJE521K MJE371K SPS 3611 1853-0036 SPS 3611
Q16 Q17 Q18	1853-0036 1854-0215 1854-0215		TRANSISTOR PNP SI PD=310MW FT=250MHZ TRANSISTOR NRN SI PD=350MW FT=300MHZ TRANSISTOR NRN SI PD=350MW FT=300MHZ	28480 04713 04713	1853-0036 SPS 3611 SPS 3611
R1 K2 R3 R4 R5	0757-0461 0658-3438 0757-0461 0757-0462 0757-0462	6 4 8	RESISTOR 68.1K 1% .125W F TC=0+-100 RESISTOR 147 1% .125W F TC=0+-100 RESISTOR 68.1K 1% .125W F TC=0+-100 RESISTOR 75K 1% .125W F TC=0+-100 RESISTOR 75K 1% .125W F TC=0+-100	24546 24546 24546 24546 24546	C4-1/8-T0-6812-F C4-1/8-T0-147R-F C4-1/8-T0-6812-F C4-1/8-T0-7502-F C4-1/8-T0-7502-F
K6 R7 R8 R9 R10	0757-0420 0757-0123 0658-3438 0658-3438 0757-0461	4	RESISTOR 750 1% .125W F TC=0+-100 RESISTOR 34.8K 1% .125W F TC=0+-100 RESISTOR 147 1% .125W F TC=0+-100 RESISTOR 147 1% .125W F TC=0+-100 RESISTOR 68.1K 1% .125W F TC=0+-100	24546 24546 24546 24546 24546	C4-1/8-T0-751-F C4- T-0 C4-1/8-T0-147R-F C4-1/8-T0-147R-F C4-1/8-T0-6812-E
K11 R12 R13 R14 R15	0757-0461 0658-3260 0757-0461 0658-3260 0757-0461	2	RESISTOR 68.1K 1% .125M F TC=0+-100 RESISTOR 464K 1% .125M F TC=0+-100 RESISTOR 68.1K 1% .125M F TC=0+-100 RESISTOR 464K 1% .125M F TC=0+-100 RESISTOR 68.1K 1% .125M F TC=0+-100	24546 91637 24546 91637 24546	C4-1/8-TO-6812-F CMF-55-1, T-1 C4-1/8-TO-6812-F CMF-55-1, T-1 C4-1/8-TO-6812-F
R16 R17 R18 R19 R20	0757-0459 0757-0459 0757-0459 0757-0459 0658-3157	6	RESISTOR 56.2K 1% .125W F TC=0+-100 RESISTOR 19.6K 1% .125W F TC=0+-100	24546 24546 24546 24546 24546	C4-1/8-IO-5622-F C4-1/8-IO-5622-F C4-1/8-IO-5622-F C4-1/8-IO-5622-F C4-1/8-IO-1962-F
R21 R22 R23 R24 R25	0757-0459 0757-0459 0698-3464 0757-0447 0757-0199	1 1 1	RESISTOR 56.2K 1% .125W F TC=0+-100 RESISTOR 56.2K 1% .125W F TC=0+-100 RESISTOR 1.47M 1% .5W F TC=0+-100 RESISTOR 16.2K 1% .125W F TC=0+-100 RESISTOR 21.5K 1% .125W F TC=0+-100	24546 24546 91637 24546 24546	C4-1/8-T0-5622-F C4-1/8-T0-5622-F MFF-1/2-10 C4-1/8-T0-1622-F C4-1/8-T0-2152-F
K26 K27 K28 R29 R30	0757-0462 0757-0462 0658-3453 0658-3158 0757-0346	2 2 2 2	RESISTOR 75K 1% .125W F TC=0+-100 RESISTOR 75K 1% .125W F TC=0+-100 RESISTOR 196K 1% .125W F TC=0+-100 RESISTOR 23.7K 1% .125W F TC=0+-100 RESISTOR 10 1% .125W F TC=0+-100	24546 24546 24546 24546 24546	C4-1/8-T0-7502-F C4-1/8-T0-7502-F C4-1/8-T0-1963-F C4-1/8-T0-2372-F C4-1/8-T0-10R0-F
R31 R32 R33 R34 R35	08 11-1552 07 57-0438 07 57-0428 07 57-0462 07 57-0462	1 4 2	RESISTOR .56 5% 2M PM TC=0+-800 RESISTOR 5.11K 1% .125M F TC=0+-100 RESISTOR 1.62K 1% .125M F TC=0+-100 RESISTOR 75K 1% .125M F TC=0+-100 RESISTOR 75K 1% .125M F TC=0+-100	75042 24546 24546 24546 24546	BWH2-9/16-J C4-1/8-T0-5111-F C4-1/8-T0-1621-F C4-1/8-T0-7502-F C4-1/8-T0-7502-F
R36 R37 R38 K39 R40 R42 R41 K44 R45 R46 R46	0757-0443 0757-0401 0658-3456 0658-3456 0658-3150 0757-0420 0658-3150 0658-3158 0757-0346 0757-0438	4 2 2 3	RESISTOR 11K 13 .125M F TC=0+-100 RESISTOR 100 13 .125M F TC=0+-100 RESISTOR 287K 13 .125M F TC=0+-100 RESISTOR 287K 13 .125M F TC=0+-100 RESISTOR 2.37K 13 .125M F TC=0+-100 RESISTOR 750 1% .125M F TC=0+-100 RESISTOR 2.37K 13 .125M F TC=0+-100 RESISTOR 23.7K 13 .125M F TC=0+-100 RESISTOR 10 13 .125M F TC=0+-100 RESISTOR 5.11K 13 .125M F TC=0+-100 RESISTOR 5.11K 13 .125M F TC=0+-100 RESISTOR 5.11K 13 .125M F TC=0+-100	24546 24546 24546 24546 24546 24546 24546 24546 24546 24546	C4-1/8-T0-1102-F C4-1/8-T0-101-F C4-1/8-T0-2873-F C4-1/8-T0-2873-F C4-1/8-T0-2371-F C4-1/8-T0-2371-F C4-1/8-T0-2371-F C4-1/8-T0-2372-F C4-1/8-T0-10R0-F C4-1/8-T0-5111-F C4-1/8-T0-5111-F
R48 R49 R50 R53 R54	06 t 3 - 8245 07 57 - 0443 06 58 - 3438 06 58 - 3453 07 57 - 0438	1	RESISTOR 820K 5% .25W FC TC=-800/+900 RESISTOR 11K 1% .125W F TC=0+-100 RESISTOR 147 1% .125W F TC=0+-100 RESISTOR 196K 1% .125W F TC=0+-100 RESISTOR 5.11K 1% .125W F TC=0+-100	01121 24546 24546 24546 24546	C88245 C4-1/8-T0-1102-F C4-1/8-T0-147R-F C4-1/8-T0-1963-F C4-1/8-T0-5111-F
R55 K56 R57 R59 K60 R58 R61 R62 R63 K64	2100-3207 0757-0401 0757-0428 0658-0082 0757-0462 0757-0462 0757-0463 0757-0443 0658-3150 0757-0420	1	RESISIOR-TRMR 5K 10% C SIDE-ADJ 1-TRN RESISTOR 100 1% .125M F TC=0+-100 RESISTOR 1.62K 1% .125M F TC=0+-100 RESISTOR 464 1% .125M F TC=0+-100 RESISTOR 75K 1% .125M F TC=0+-100 RESISTOR 75K 1% .125M F TC=0+-100 RESISTOR 75K 1% .125M F TC=0+-100 RESISTOR 11K 1% .125M F TC=0+-100 RESISTOR 12K 1% .125M F TC=0+-100 RESISTOR 12K 1% .125M F TC=0+-100 RESISTOR 750 1% .125M F TC=0+-100	73138 24546 24546 24546 24546 24546 24546 24546 24546 24546	72-145-0 C4-1/8-T0-101-F C4-1/8-T0-1621-F C4-1/8-T0-4640-F C4-1/8-T0-7502-F C4-1/8-T0-7502-F C4-1/8-T0-7502-F C4-1/8-T0-1102-F C4-1/8-T0-1102-F C4-1/8-T0-12-F C4-1/8-T0-12-F C4-1/8-T0-12-F C4-1/8-T0-12-F C4-1/8-T0-12-F C4-1/8-T0-751-F
#101 R102 R103 R104 R106	1810-0125 1810-0125 1810-0151 1810-0151 1810-0037	2 2 2	NETWORK-RES 8-PIN-SIP .125-PIN-SPCG NETWORK-RES 8-PIN-SIP .125-PIN-SPCG NETWORK-RES 7-PIN-SIP .15-PIN-SPCG NETWORK-RES 7-PIN-SIP .15-PIN-SPCG NETWORK-RES 16-PIN-DIP .1-PIN-SPCG	11236 11236 28480 28480 11236	750 750 1810-0151 1810-0151 760 SERIES/16 PIN

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
K1J7	1810-0037		READ/WRITE ASSEMBLY CONT'D. NETWORK-RES 16-PIN-DIP .1-PIN-SPCG	11236	760 SERIES/16 PIN
U1 U2 U3 U4 U5	1826-0138 1820-1260 1820-0491 1826-0200 1826-0200	1 1 1 2	IC LM 339 CEMPARATOR IC-DIGITAL SN74221N TTL DUAL IC-DIGITAL SN74145N TTL 4 BCD-TO-DEC IC MC 1420 OP AMP IC MC 1420 OP AMP	27014 01295 01295 04713 04713	LM339N SN74221N SN74145N MC1420G MC1420G
U6 U7 U8 U9 U10	1826-0139 1826-0139 1826-0139 1826-0139 1820-0577	4 2	IC MC 1458 OP AMP IC MC 1458 OP AMP IC MC 1458 OP AMP IC MC 1458 OP AMP IC—DIGITAL SN7416N TTL HEX 1	04713 04713 04713 04713 01295	MC1458P1 MC1458P1 MC1458P1 MC1458P1 SN7416N
U11 U12 U13 U14 U15	1820-0514 1820-1208 1820-1416 1820-1202 1820-1425	1 1 1 1	IC-DIGITAL SN7426N TTL QUAD 2 NAND IC-DIGITAL SN74LS32N TTL LS QUAD 2 OR IC-DIGITAL SN74LS14N TTL LS HEX 1 INV IC-DIGITAL SN74LS10N TTL LS TPL 3 NAND IC-DIGITAL SN74LS10N TTL LS QUAD 2 NAND	01295 01295 01295 01295 01295	SN7426N SN74L S32N SN74L S1 6N SN74L S1 6N SN74L S1 32N
U16 U17 U18	1820-0981 1820-0577 1820-1201	1	IC-DIGITAL CD4016AY CMOS QUAD BILATL IC-DIGITAL SN7416N TTL HEX I IC-DIGITAL SN74LSOBN TTL LS QUAD 2 AND MISCELLANEOUS	02735 01295 01295	CD4016AY SN7416N SN74L SO8N
	0340-0585 1200-0081 2190-0004 2200-0143 2260-0002	1 4 4 4	INSULATOR MICA INSULATOR-BSHG-FLG NYLON MASHER-LK INTL T NO4 .115-IN-ID SCREM-MACH 4-40 .375-IN-LG PAN-HD-POZI NUT-HEX-DBL-CHAM 4-40-THD .062-THK	28480 28480 0G791 28480 28480	0340-0585 1200-0087 418-8C EVERLOCK MASHER 2200-0143 2260-0005
	6040-0239 02640-20001	1	GREASE:SILICONE COMPOUND MEAT SINK	05820 28480	120-56M 02640-28001

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	02640-60033	1	CTU INTERFACE ASSEMBLY DATE CODE: B-1508-22 REVISION DATE: 04-15-76	28480	02640-60033
C1 G2 G3 G4 C5	0180-0393 0160-2055 0160-2055 0160-2055 0160-2055	1 17	CAPACITOR-FXD 39UF+-10% 10VDC TA CAPACITOR-FXD .01UF +80-2U% 100MVDC CER	56289 28480 28480 28480 28480	150D396 X901 082 0160-2055 0160-2055 0160-2055 0160-2055
66 67 68 69 610	0140-2055 0160-2055 0160-2055 0160-2055 0160-2055		CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .01UF +80-20% 100WVDC CER	28480 28480 28480 28480 28480	0160-2055 0160-2055 0160-2055 0160-2055 0160-2055
G11 G12 G13 G14 G15	0160-2055 0160-2055 0160-2055 0160-2055 0160-2055		CAPACITOR-FXD -01UF +80-20% 100WVDC CER	28480 28480 28480 28480 28480	0160-2055 0160-2055 0160-2055 0160-2055 0160-2055
C16 C17 C18	0160-2055 0160-2055 0160-2055		CAPACITOR-FXD .01UF +80-20% 10GWVDC CER CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .01UF +80-20% 100WVDC CER	28480 28480 28480	0160-2055 0160-2055 0160-2055
E1 E2 E3	0360-0124 0360-0124 0360-0424	3	TERMINAL-STUD SGL-PIN PRESS-MTG TERMINAL-STUD SGL-PIN PRESS-MTG TERMINAL-STUD SGL-PIN PRESS-MTG	28480 28480 28480	0360-0124 0360-0124 0360-0124
K1	1810-0121	1	NETWORK-RES 9-PIN-SIP .15-PIN-SPCG	28480	1810-0121
U11 U12 U13 U14 U15	1820-1209 1820-1209 1820-1100 1820-1276 1820-1196	5 2 2 2	IC-DIGITAL SN74LS38N ITL LS QUAD 2 NAND IC-DIGITAL SN74LS38N ITL LS QUAD 2 NAND IC-DIGITAL SN74L298N ITL QUAD 2 IC-DIGITAL SN74LS194AN ITL LS R-S IC-DIGITAL SN74LS174N ITL LS HEX	01295 01295 01295 01295 01295	SN74L S38N SN74L S38N SN74298N SN74L S1 94AN SN74L S1 74N
U16 U17 U18 U19 U21	1820-1281 1820-1282 1820-1201 1820-1203 1820-1112	1 3 1 3 2	IC-DIGITAL SN74LS139N TTL LS DUAL 2 IC-DIGITAL SN74LS109N TTL LS DUAL IC-DIGITAL SN74LS109N TTL LS QUAD 2 AND IC-DIGITAL SN74LS1N TTL LS TPL 3 AND IC-DIGITAL SN74LS1N TTL LS TPL 3 AND IC-DIGITAL SN74LS74N TTL LS DUAL	01295 01295 01295 01295 01295	SN74L S1 39N SN74L S109N SN74L S08N SN74L S11N SN74L S74N
U22 U23 U24 U25 U20	1820-1209 1820-1203 1820-1112 1820-1282 1820-1282		IC-DIGITAL SN74LS38N TTL LS QUAD 2 NAND IC-DIGITAL SN74LSIIN ITL LS TPL 3 AND IC-DIGITAL SN74LS74N TTL LS DUAL IC-DIGITAL SN74LS109N TTL LS DUAL IC-DIGITAL SN74LS109N TTL LS DUAL	01295 01295 01295 01295 01295	SN76L S38N SN74L S11N SN74L S74N SN74L S109N SN74L S109N
U27 U28 U29 U31 U32	1820-1197 1820-1196 1820-1211 1820-1209 1820-1209	2	IC-DIGITAL SN74LSOON TTL LS QUAD 2 NAND IC-DIGITAL SN74LSI74N TTL LS HEX IC-DIGITAL SN74LS86N TTL LS QUAD 2 IC-DIGITAL SN74LS88N TTL LS QUAD 2 NAND IC-DIGITAL SN74LS38N TTL LS QUAD 2 NAND	01295 01295 01295 01295 01295	SN74L SOON SN74L 51 74N SN74L 586N SN74L 588N SN74L 538N
U33 U34 U35 U30 U30	1820-1100 1820-1276 1820-1199 1820-1202 1820-1215	3 3 1	IC-DIGITAL SN74298N TTL QUAD 2 IC-DIGITAL SN74LS194AN TTL LS R-S IC-DIGITAL SN74LS04N TTL LS HEX 1 IC-DIGITAL SN74LS10N TTL LS TPL 3 NAND IC-DIGITAL SN74LS136N TTL LS QUAD 2	01295 01295 01295 01295 01295	SN74298N SN74L5194AN SN74L504N SN74L510N SN74L5136N
0117 0111 033 038	1820-1202 1820-1199 1820-1203 1820-1197 1820-1202		IC-DIGITAL SN74LSION ITL LS TPL 3 NAND IC-DIGITAL SN74LSOAN ITL LS HEX 1 IC-DIGITAL SN74LSIIN TTL LS TPL 3 AND IC-DIGITAL SN74LSION ITL LS QUAD 2 NAND IC-DIGITAL SN74LSION TTL LS TPL 3 NAND	01295 01295 01295 01295 01295	SN74L S1 QN SN74L S04N SN74L S1 1N SN74L S00N SN74L S1 ON
U210 U211 U212 U213 U214	1820-1144 1820-1199 1820-0716 1820-0716 1820-0716	1 4	IC-DIGITAL SN74LSO2N TTL LS QUAD 2 NOR IC-DIGITAL SN74LSO4N TTL LS HEX 1 IC-DIGITAL SN74161N TTL BIN SYNCHRO IC-DIGITAL SN74161N TTL BIN SYNCHRO IC-DIGITAL SN74161N TTL BIR SYNCHRO	01295 01295 01295 01295 01295	SN74LSO2N SN74LSO4N SN74L61N SN74L61N SN74L61N
0317 0317 0310	1820-1208 1820-0716 1820-1194 1820-1194	2	IC-DIGITAL SN74LS32N TTL LS QUAD 2 OR IC-DIGITAL SN74L61N TTL BIN SYNCHRO IC-DIGITAL SN74LS193N TTL LS BIN IC-DIGITAL SN74LS193N TTL LS BIN	01295 01295 01295 01295	SN74L S32N SN74161N SN74L S1 93N SN74L S1 93N
WL	8159-0005	1	WIRE 22AWG W PVC 1X22 80C	28480	8159-0005

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	02440-60034	1	CTU ELECTRONICS ASSEMBLY	28480	02640-60034
			DATE CODE: B-1632-22 REVISION DATE: 08-04-76		
C1 C2 L3 C4	0160-1701 0160-0153 0160-0393 0160-0194	1 1 1	CAPACITOR-FXO 6.8UFF-20% 6VDC TA CAPACITOR-FXO 1000PF +-10% 200MVDC POLYE CAPACITOR-FXO 39UFF-10% 10VDC TA CAPACITOR-FXO -015UF +-10% 200MVDC POLYE	56289 56289 56289 56289	1509685X0006A2 292P10292 1500396X9010B2 292P15392
LKŻ	1901-0040	1	BIODE-SMITCHING 30V 50MA 2NS DC-35	28480	1901-0040
021	2140-0450 4040-1017	1	LAMP-INCAND 7362 SVDC 115MA T-1-3/4-BULB SHIELD, LIGHT	71744 28480	CM7-7362-AS258 4040-1017
nī.	1251-3192	1	CONNECTOR 3-PIN M POST TYPE	27264	09-60-1031(2403-03A)
₩2 ₩3	1854-0071 1853-0020	1	TRANSISTGR NPN SI PD=300MW FT=200MHZ Transistor PNP SI PD=300MW FT=150MHZ	28480 28480	1854-0071 1853-0020
K1 K2 K3 K4 R5	06 83-0475 06 83-5605 06 83-1015 06 83-1525 06 83-1035	1 1 1 1 3	RESISTOR 4.7 5% .25W FC TC=-400/+500 RESISTOR 56 5% .25W FC TC=-400/+500 RESISTOR 100 5% .25W FC TC=-400/+500 RESISTOR 1.5K 5% .25W FC TC=-400/+700 RESISTOR 10K 5% .25W FC TC=-400/+700	01121 01121 01121 01121 01121	C84765 C85605 C81015 C81525 C81035
KO K7 KB K9 K1U	06 58-3159 07 57+0459 06 58-3158 06 83-1035 06 83-1035	1 1 1	RESISTOR 26.1K 17.125W F TC=0+-100 RESISTOR 56.2K 17.125W F TC=0+-100 RESISTOR 23.7K 17.125W F TC=0+-100 RESISTOR 10K 57.25W FC TC=-400/+700 RESISTOR 10K 57.25W FC TC=-400/+700	24546 24546 24546 01121 01121	C4-1/8-TO-2612-F C4-1/8-TO-5622-F C4-1/8-TO-2372-F C81035 C81035
K11 R12	0683-6835 0683-1505	1 1	RESISTOR 68K 5% -25W FC TC=-400/+800 RESISTOR 15 5% -25W FC TC=-400/+500	01121 01121	CB6835 CB1505
U1	1820-0535	1	IC-DIGITAL SN75451BP TTL DUAL 2 AND	01295	SN754518P
U2 U3	1826-0373 1820-0207 1251-4099	1 2	IC LINEAR IC-DIGITAL 9601PC TTL MONOSTBL CONN - SC	07263	9601PC

1 CIU TRAMSPORT ASSEMBLY 28-80 02-94-0-0050 1	Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
REVISION DATE: 06-30-76 06 24-0314 3 SCREM-TPG 4-20 .375-IN-LG PAN-HD-P021 28480 0624-0315 1460-1381 2 SPRING-EXT .187-IN-OD .75-IN-LG MUM CD 84830 LE-022B-00-MM 1520-0067 2 SWICK MOUNT .44-EFF-MGT .31" 0C 61957 2150-0020 3 WASHER-LK HLCL NO5 .128-IN-ID 28480 2190-0020 23 60-0205 2 SCREM-MACH 6-32 .75-IN-LG PAN-HD-P021 28480 2190-0020 23 60-0207 2 WASHER-FL MTLC NO6 .149-IN-ID 80120 AN960C-6 1 ASSY, CTU BASE 28480 02640-60054 02 640-60055 1 ASSY, MOTOR/TACH 28480 02640-60055		02440-60050	1	CTIL TRANSPORT ASSEMBLY	284-90	02640-60050
2340-0205 3050-0227 7124-5066 02640-40016 02640-60054 02640-60055 1 ASSY, CTU BASE 23400-0205 28480 23400-0205 28480 23400-0205 28480 28480 02640-60055 1 ASSY, MOTOR/TACH 28480 02640-60055		06 24-0314 1460-1381 1460-1440 1520-0067	3 2 1 2	REVISION DATE: 06-30-76 SCREM-TPG 4-20 .375-IN-LG PAN-HD-POZI SPRING-EXT .187-IN-OD .75-IN-LG MUM CD SPRING-CPRSN .12-IN-OD .25-IN-LG MUM CD SHUCK MOUNT .44-EFF-HGT .31" OC	28480 84830 84830 61957	0624-0315 LE-0228-00-MW LC-014A-1MW MELL-NUT E-632
02640-60055 1 ASSY, MOTOR/TACH 28480 02640-60055		2360-0205 3050-0227 7124-5066 02640-40016	2 2 1	SCREM-MACH 6-32 .75-IN-LG PAN-HD-POZI MASHER-FL MTLC NO6 .149-IN-ID LABEL PANL	28480 80120	2360-0205 AN960C-6 02640-40016
		02640-60055	1	ASSY. MOTOR/TACH	28480	02640-60055
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Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	02640-60055	2	MUTOR/TACHOMETER ASSEMBLY REVISION DATE: 03-13-76	28480	02640~60055
	0050-1831 0463-0333 0470-0443 0515-0029 0624-0296	1 1 3 2	CASTING BUMPER FOOT, RUBBER 0.312" W ADHESIVE BONDING:#224-1 SCREW-MACH M2 X 0.40 6-MM-LG 90 DEG SCREW-TPG 2-56 .375-IN-LG PAN-HO-POZI	28480 13862 00000 28480 28480	0050-1831 459 0BD 0515-0029 0624-0300
	1251-2510 1251-2599 1460-0249 1460-1412 2150-0889	1 2 1 1 2	CONNECTOR 2-PIN M UTILITY CONTACT-CONN MALE CRP .093-IN-CONT-SZ CABLE TIE .062625-DIA .091-MD NYL MIREFORM .699-IN-M I.032-IN-LB MUN CD WASHER-SPR BLVL NO2 .093-IN-ID	27264 27264 59730 28480 70472	03-09-2022 02-09-2116 TYB-23M-8 1460-1412 B0187-007
	3140-0544 02640-60057 02640-60076 02640-60074	1 1 1	MOTUR-DC PERM MAG 6V 5000-RPM ASSY, TACH CCIL ASSY, DSC/CAPSTAN ASSY, MAGNET	28480 28480 28480 28480	3140-0544 02640-60057 02640-60076 02640-60074
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Reference Designation	HP Part Number	Qty	Description Description	Mfr Code	Mfr Part Number
	02 640-60056	1	HEAD BRIDGE ASSEMBLY REVISION DATE: 03-13-76	28480	02640-60056
	0624-0307 0624-0333 1950-0435 1950-0492 02640-00012	2 1 1 2	SCREW-TPG 2-28 .25-IN-LG PAN-HD-PHL STL SCREW-TPG 4-20 .25-IN-LG PAN-HD-PDZI STL PHOTOTRANSISTOR VAX-20V BVECQ=5V LED-INFRARED IF=100MA-MAX BVR=2V VF=1.8V SWITCH, CONTACT	28480 28480 07263 28480 28480	0624-0309 0624-0337 FPT120 1990-0492 02640-00012
	02640-40015 02640-60034 02640-60066 02640-60067	2 1 1	PLUNGER ASSY, CTU ELECTRONICS ASSY, CABLE £TU ASSY, HEAD	28480 28480 28480 28480	02640-40015 02640-60034 02640-60066 02640-60067
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Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	02 €40 ~ 600 6 6	1	CTU CABLE ASSEMBLY	28480	02640-60066
	04C0-0191 1251-2499 8120-1458	1 2	REVISION DATE: 05-15-76 GKOMMET. CHANNEL 0.125" W CONNECTOR 14-PIN M RECTANGULAR CA RBN 14 x 28 GA UL	06915 76381 76381	DSC-10UROSTRIP SPEC 3406-0000 3365-14
			CA NOR IT X 20 MA UL	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	333 31
	L				

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
Designation	02640-60102 0965-0126 1460-1448 2150-0006 2360-0219 4040-1014 4040-1015 02644-00003 0460-1062 3050-0247	1 4 2 4 4 2 1 1 4	CTU BEZEL ASSEMBLY REVISION DATE: 09-18-76 "O" RING114"-ID SPRING-TRSN MUN CD MASHER-LK HLCL NO6 .141-IN-ID SCREW-MACH 6-32 1.375-IN-LG PAN-HD-POZI DUGR. BEZEL BEZEL SZIFFENER, BEZEL TAPE - INDL .375W WASHER - #6 FIBER	28480 28480 28480 28480 28480 28480 28480	02640-60102 03.006 1460-1448 2190-0006 2360-0219 4040-1014 4040-1015 02644-00003
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